· · · · · · · · · · · · · · · · · · ·	Valchand College of Engineering, Sangli (Government Aided Autonomous Institute) AY 2023-24						
Course Information							
Programme	B.Tech. (Electronics Engineering)						
Class, Semester	Third Year B. Tech., Sem V						
Course Code	6EN301						
Course Name	Digital Signal Processing						
Desired Requisites:	Signals and Systems						

ng Scheme	Examination Scheme (Marks)					
3 Hrs/week	MSE	ISE	ESE	Total		
-	30	20	50	100		
		Cred	lits: 3			
	Course	Ohiectives	<u> </u>			
		3 Hrs/week MSE - 30	3 Hrs/week MSE ISE - 30 20	3 Hrs/week MSE ISE ESE - 30 20 50 Credits: 3		

To illustrate the fundamental concepts of Signal Processing. 1

To explain the different techniques for design of filters and multirate systems.

To enable the students for the design and development of DSP systems.

	Course Outcome	es (CO) with	Bloom's T	axonomy Level
At the end of the co	urse, the students will	be able to,		
CO1 Solve Discr	ete Fourier Transform	in efficient i	manner	

2

3

CO2	Analyze the structures for Discrete Time systems	Analyze
CO3	Design the FIR, IIR Digital Filters for given specifications	Create
CO4	Describe the fundamentals of Multirate DSP and Wavelet Transform	Evaluate

Apply

Module	Module Contents	Hours
I	Discrete Fourier Transform and its Computation Introduction, The Discrete Fourier Series and its Properties, The Fourier Transformof Periodic signals, Sampling of the Fourier Transform, The Discrete Fourier Transform and its Properties, Efficient Computation of the Discrete Fourier Transform, Decimation-in-Time FFT Algorithms, Decimation-in- Frequency FFT Algorithms, Implementation of FFT Algorithms for IIR Systems.	8
п	Structures for Discrete-Time Systems Introduction, Block Diagram Representation of Difference Equations, Signal Flow Graph Representation of Difference Equations, Basic Structures of FIR Systems, Basic Network structures	4
III	Filter Design Techniques-FIR Filters Introduction, Design of FIR Filter by Windowing, Properties of commonly used windows, Linear Phase property of FIR Filter, Kaiser Window Filter design, Discrete Time Differentiator	8
IV	Filter Design Techniques-IIR Filters Introduction, Design of Discrete-time IIR Filters from Continuous-time Filters, Filter Design by Impulse Invariance, Filter Design by Bilinear Transformation, Frequency Transformations of Low pass IIR Filters	8
v ور	Multirate Digital Signal Processing Introduction, Decimation and interpolation, Sampling rate conversion, Multistage Implementation of Sampling rate conversion, Sampling rate conversion for Bandpass signals, Sampling rate conversion by arbitrary factor, Applications of Multirate DSP	8
VI	Introduction to Wavelet Transform STFT, Wavelets representation, Haar Wavelet, Daubachis Wavelet, Filter BankRepresentation	4

Sies

	Textbooks							
1	Sanjit K. Mitra, "Digital Signal Processing: A Computer Based Approach",4th Edition, Tata McGraw-Hill Publication.							
2	Oppenheim & Schafer, "Discrete Time Signal Processing", ,2 nd Edition, Pearson education.							
3								
4								
	References							
1	J. G. Proakis, "Digital Signal Processing", Prentice Hall India							
2								
3								
4								
	Useful Links							
1	www.nptel.ac.in							
2								
3								
4								

CO-PO Mapping														
		Programme Outcomes (PO)											PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													2
CO2		3												2
CO3				2										2
CO4	2													2
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	of the c	ourse	must m	ap to at	t least c	one PO.								

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

			1	Autonomous Institu	116)			
				2023-24				
				Information				
Progra			B. Tech. (Electron					
	Semester		Third Year B. Te	ch., Sem. V				
	e Code		6EN302					
	e Name		Embedded Syster	-				
Desire	d Requisi	tes:	Microcontroller P	eripherals and Int	erfacing theory and lab			
1	Teaching	Scheme		Examination	Scheme (Marks)			
Lectur	re	3 Hrs/week	MSE	ISE	ESE	Total		
Tutori	ial	-	30	20	50	100		
				Cre	dits: 3			
			0					
1	To illust	rate the features	of ARM architectu	Objectives				
					nd programming of differ	ent		
2			ed controller. Ex. I			CIII		
3			for the design and					
4	To encou	rage students to	provide solution for	or real world prob	lems using embedded sys	tems .		
		Course	Outcomes (CO) w	ith Bloom's Taxo	onomy Level			
At the			ents will be able to	·				
CO1						Apply		
CO2		vrite assembly and C program to configure and use internal peripherals ARM Apply						
<u> </u>	microcor							
CO3	microcor		find operating	parameters of	peripheral in ARM	Analyz		
CO4			l embedded system	using embedded	C programming and			
	0	crocontroller.				Create		
Modu	le		Module	Contents		Hours		
	Arch	itecture						
					anization, Programmers			
Ι					Program Status Register,	6		
		•		· ·	bry Accelerator module,			
	-		chitecture of ARM	with 8051				
		edded C Progra		v M2 mm	ing example, Software			
					gramming, Startup code,			
II					Connect block, I/O	8		
					ng. External Peripheral			
			itch, LCD, Motor,					
			of ARM Microcol		· ·			
III	Interr	upt system in A	ARM7 / ARM Co	rtex M3, Interrup	t Controller, FIQ, IRQ,	6		
111					ency, Nested interrupts,			
			terrupt configurati	on and Programm	ing examples.			
			Microcontroller	. ~				
TT 7					latch facility of timer			
IV	and c	onfiguration of i	t using registers. P	uise Width Modu	lator, RTC operation and			
1 V								
1 v	Progr		dog timer, Analo		verter, Digital to analog			

	Communication Protocols	
V	On chip serial ports, Serial port programming, setting baud rate, Using UART buffer, printf for serial data transfer, interrupt based serial port handling, I2C protocol, Using I2C for interfacing external EEPROM, SPI protocol and programming.	7
VI	Application DevelopmentFinite state machine in designing Embedded Systems, Design considerations for embedded system design, Design of a simple general purpose ARM kit, Case studies of ARM based applications.	4
	Tradit a she	
1	Textbooks	
1	Andrew Sloss, ARM System Developer's Guide, Elsevier India, 2005	
2	Joseph Yiu, "The Definitive Guide to ARM® Cortex®-M3 and Cortex®-M4 P Newnes; 3rd edition	rocessors",
3	"Textbook of EMBEDDED SYSTEM", NA. VIKRAMAN	
4	"Introduction to Microprocessor Based Systems Using the ARM Processor" by Kris	Schindler
	References	
1	ARM inc, ARM Reference Manual, ARM, inc., NA, 2011	
2	Technical references, data sheets and user manuals of respective controller	
3	Yifeng Zhu, "Embedded Systems with Arm Cortex-M Microcontrollers in Language and C", E-Man Press LLC	Assembly
4	Frank Vahid and Tony Givargis, "Embedded System Design", Wiley	
	Useful Links	
1	https://nptel.ac.in/	
2	https://in.coursera.org/	
3	https://www.nxp.com/	
4	https://www.arm.com/	

	CO-PO Mapping													
		Programme Outcomes (PO)											PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													
CO2	3													
CO3		3			3									
CO4			3											2
					1: Lo	w, 2: N	ledium	, 3: Hig	gh					

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be quiz, seminar, assignments or any interactive activity etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

			1	Autonomous Institu					
				2023-24					
				nformation					
Progra			B.Tech. (Electron	<u> </u>					
Class, Semester Third Year B. Tech., Sem V									
Course Code 6EN303									
Course Name Digital Communication Engineering									
Desire	d Requisit	es:	Analog Commun	ication Engineerin	g				
	Teaching Scheme Examination Scheme (Marks)								
Lectur	0	3 Hrs/week	MSE	ISE	ESE	Total			
Tutori			30	20	50 ESE	100			
I ULUIT			50		lits: 3	100			
				Crea	шэ. <i>Э</i>				
			Course	Objectives					
1	To equip	the students wit	h the advanced kno	•	communication.				
2					in presence of nois	3			
		Course	Outcomes (CO) w	ith Bloom's Taxo	nomy Level				
			ents will be able to						
CO1			probability theory			Understand			
CO2			d error control cod			Apply			
CO3	Analyze environm	•	nce of digital co	ommunication sy	stem with differen	Apply			
Modu	le		Module	Contents		Hours			
	Rand	om variable an	d random Process	ses					
					variable, Uniform				
Ι			, Gaussian Rand						
-		movement generation function, Central limit theorem, Classification of Random Processes, Stationary; Time average; Ergodic Process; Wide sense							
				stationary Process					
		Spread Spectrum Signals for Digital Communication:Model of spread spectrum digital communication system, Direct sequence							
					em, Direct seauend	e .			
II		1 of spread sp	ectrum digital con	mmunication syst	em, Direct sequenc rum signals, CDMA				
II	spread Time	l of spread sp l spectrum sign hopping SS, Sy	ectrum digital con als, Frequency ho nchronization of S	mmunication syst pped spread spect S systems.	rum signals, CDMA				
II	spread Time Digita	l of spread sp d spectrum sign hopping SS, Sy al Communicat	ectrum digital con als, Frequency ho nchronization of S ion through Fadin	mmunication syst pped spread spect S systems. ng Multipath Cha	rum signals, CDMA	A, 4			
II	spread Time Digit Chara	l of spread sp l spectrum sign hopping SS, Sy al Communicat cterization of	ectrum digital con als, Frequency ho nchronization of SS ion through Fadin fading multipat	mmunication syst pped spread spect S systems. ng Multipath Cha h channels, Th	rum signals, CDMA nnels: e effect of signa	A, 4			
	spread Time Digita Chara chara	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch	mmunication syst pped spread spect S systems. ng Multipath Cha h channels, Th annel model, Fre	rum signals, CDMA nnels: e effect of signa quency nonselective	A, 4 al e, 5			
	spread Time Digita Chara charad Slowl	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch hel, Diversity tech	mmunication syst pped spread spect S systems. ng Multipath Cha h channels, Th annel model, Fre niques for fading	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel	A, 4 al e, 5			
	spread Time Digita Chara charad Slowl	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch	mmunication syst pped spread spect S systems. ng Multipath Cha h channels, Th annel model, Fre niques for fading	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel	A, 4 al e, 5			
	spread Time Digit a Charad charad Slowl Digita	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch hel, Diversity tech frequency selective	mmunication syst pped spread spect S systems. ng Multipath Cha h channels, Th annel model, Fre niques for fading	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel	A, 4 al e, 5			
III	spread Time Digita Chara chara Slowl Digita Com What	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann al signals over a nunication Lin the System Lin	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch al, Diversity tech frequency selective k Analysis k Budget, the Chat	mmunication syst pped spread spect <u>S systems.</u> ng Multipath Cha h channels, Th annel model, Fre niques for fading e, Slowly fading com nnel, Received Sig	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel nannel.	A, 4 al e, 5 s, 5			
	spread Time Digita Chara charad Slowl Digita Vhat Powe	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chanr il signals over a nunication Lin the System Lin r, Link Budget	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch hel, Diversity tech frequency selective k Analysis k Budget, the Cha Analysis, Noise F	mmunication syst pped spread spect <u>S systems.</u> ng Multipath Cha h channels, Th annel model, Fre niques for fading e, Slowly fading com nnel, Received Sig	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel nannel.	A, 4 al e, 5 s, 5			
III	spread Time Digita Chara charad Slowl Digita Vhat Powe	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann al signals over a nunication Lin the System Lin	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch hel, Diversity tech frequency selective k Analysis k Budget, the Cha Analysis, Noise F	mmunication syst pped spread spect <u>S systems.</u> ng Multipath Cha h channels, Th annel model, Fre niques for fading e, Slowly fading com nnel, Received Sig	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel nannel.	A, 4 al e, 5 s, 5			
III	spread Time Digita Chara chara Slowl Digita Com What Powe Temp	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann d signals over a nunication Lin the System Lin r, Link Budget erature, Sample	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch lel, Diversity tech frequency selective k Analysis k Budget, the Cha Analysis, Noise F Link Analysis	mmunication syst pped spread spect <u>S systems.</u> ng Multipath Cha h channels, Th annel model, Fre niques for fading e, Slowly fading com nnel, Received Sig	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel nannel.	A, 4 al e, 5 s, 5			
III	spread Time Digita Chara charad Slowl Digita Com What Powe Temp	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chann al signals over a nunication Lin the System Lin r, Link Budget erature, Sample	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch hel, Diversity tech frequency selective k Analysis k Budget, the Char Analysis, Noise F Link Analysis	mmunication syst pped spread spect S systems. ng Multipath Cha h channels, Th annel model, Fre niques for fading e, Slowly fading con nnel, Received Sig	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel nannel. gnal Power and Nois perature, and Syster	A, 4 al e, 5 s, 5 de 8			
III	spread Time Digita Chara charad Slowl Digita What Powe Temp Infor Meas	l of spread sp d spectrum sign hopping SS, Sy al Communicat cterization of cteristics on th y fading chanr il signals over a nunication Lin the System Lin r, Link Budget erature, Sample mation Theory ure of Informa	ectrum digital con als, Frequency ho nchronization of S ion through Fadin fading multipat e choice of a ch hel, Diversity tech frequency selective k Analysis k Budget, the Char Analysis, Noise F Link Analysis	mmunication syst pped spread spect <u>S systems.</u> ng Multipath Cha h channels, Th annel model, Fre niques for fading e, Slowly fading controls nnel, Received Sig igure, Noise Tem	rum signals, CDMA nnels: e effect of signa quency nonselective multipath channel nannel.	A, 4 al e, 5 s, 5 e n 8 g			

VI	Error-Control Coding Errors, Error-Detection Methods, Automatic Repeat Request (ARQ), Block Codes, Convolutional Codes, Compound Codes	7
	Textbooks	
1	T.L. Singal, "Analog and Digital Communication",6th Edition, Mc Graw Hill, 20	12
2	Roy Blake, "Electronic Communication System", Thomson Publications, 2nd E	
		,
	References	
1	Simon Hykin, "Communication System", 4th Edition, John Wiley & Sons, 2000	
2	B P Lathi, "Modern Digital and Analog Communication System", 4 th Ed University Press, 2017	lition, Oxford
	Useful Links	
1	www.nptel.ac.in	
2		
3		
4		

	CO-PO Mapping													
		Programme Outcomes (PO) PSO									50			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	2													2
CO2		1												
CO3			1										2	
CO4			2										2	
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High														
Each CO	Each CO of the course must map to at least one PO.													

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

Walchand College of Engineering, Sangli (Government Aided Autonomous Institute)					
AY 2022-23					
Course Information					
Programme	B.Tech. (Electronics Engineering)				
Class, Semester	Third Year B. Tech., Sem I				
Course Code	6EN351				
Course Name	Digital Signal Processing Lab				
Desired Requisites:	Signals and Systems				

Teaching	g Scheme	Examination Scheme (Marks)						
Practical	2 Hrs/ Week	LA1	LA2	Lab ESE	Total			
Interaction		30	30	40	100			
		Credits: 1						

Course Objectives						
1	The objective of the course is to work out for the convolution.					
2	Correlation, DFT, IDFT, Block convolution.					
3	Signal smoothing, filtering of long duration signals.					
4	Spectral analysis of signals using MATLAB simulation.					
	Course Outcomes (CO) with Bloom's Taxonomy Level					
At the	end of the course, the students will be able to,					
CO1	Illustrate the basic operations of Signal processing	Apply				
CO2	Analyze the spectral parameter of window functions	Understand				
CO3	Create IIR, and FIR filters for band pass, band stop, low pass and high pass filters	Create				
CO4	Demonstrate multirate DSP and wavelet transform	Evaluate				

List of Experiments / Lab Activities/Topics

List of Lab Activities:

- 1. Generation of different signals using MATLAB.
- 2. Calculation of DFT and plot Magnitude, Phase response for the same.
- 3. Calculation of IDFT and plot Magnitude response for the same.
- 4. Implementation of Median Filter.
- 5. Implementation of Moving Average Filter.
- 6. Find Circular Convolution of given sequences.
- 7. Illustration of Overlap-Add Method.
- 8. Design of simple filter.
- 9. Design of FIR filter using different window functions.
- 10. Design of FIR filter using Kaiser window.
- 11. To plot frequency response of low pass filter using Kaiser window for differenttuning parameters.
- 12. Illustration of Up sampling of signal.
- 13. Illustration of Down sampling of signal.
- 14. Illustration of Effect of window length.
- 15. Illustration of Effect of Up sampling in Frequency Domain.

	Textbooks						
1	Sanjit K. Mitra, "Digital Signal Processing: A Computer Based Approach",4 th Edition, Tata McGraw-Hill Publication.						
2	Oppenheim & Schafer, "Discrete Time Signal Processing", ,2 nd Edition, Pearson education.						
3							
4							
References							
1	J. G. Proakis, "Digital Signal Processing", Prentice Hall India						
2							

3							
4							
	Useful Links						
1	www.nptel.ac.in						
2							
3							
4							

	CO-PO Mapping													
		Programme Outcomes (PO) PSO									50			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													2
CO2		3												2
CO3				2										2
CO4	2													2
The strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High														
Each CO	Each CO of the course must map to at least one PO, and preferably to only one PO.													

Assessment							
	1	· · · ·	LA2 and Lab ESE. %), LA1+LA2 should be min 40%				
Assessment	Based on	Conducted by	Typical Schedule	Marks			
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30			
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30			
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40			

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

Walchand College of Engineering, Sangli (Government Aided Autonomous Institute)						
AY 2023-24						
Course Information						
Programme	B. Tech. (Electronics Engineering)					
Class, Semester	Third Year B. Tech., Sem. V					
Course Code	6EN352					
Course Name	Embedded System Design LAB					
Desired Requisites:	Microcontroller Peripherals and Interfacing theory and lab					
	·					
Teaching Scheme	Examination Scheme (Marks)					
	T A 4	T 4 0	TIDOD	T ()		

Teaching	Scheme	Examination Scheme (Marks)					
Practical	2 Hrs/ Week	LA1	LA2	Lab ESE	Total		
Interaction	-	30	30	40	100		
		Credits: 2					

	Course Objectives						
1	Write, simulate and debug assembly and C programs for LPC2148 / LPC1768 microcontroller						
2	Write, simulate, download and test C programs for microcontroller using development board						
3	3 Develop C program for implementing given or required system operation.						
	Course Outcomes (CO) with Bloom's Taxonomy Level						
At the	end of the course, the students will be able to,						
CO1	Apply programming skills to integrate hardware peripherals of ARM microcontroller.	Apply					
CO2	Test and debug programs for ARM microcontroller.	Analyze					
CO3	Develop and demonstrate small embedded systems using ARM C programming and hardware peripherals for ARM microcontroller.	Create					

List of Experiments / Lab Activities/Topics

List of Lab Activities:

List of Experiments:

- 1. Experiment 1: Introduction of the development tools and kit
- 2. Experiment 2: Simple assembly language, embedded C program and study of startup.s file
- 3. Experiment 3: GPIO Programming
- 4. Experiment 4: PLL Programming
- 5. Experiment 5: Interrupt programming (IRQ and NV-IRQ)
- 6. Experiment 6: FIQ programming and comparison of FIQ with VIRQ and NVIRQ
- 7. Experiment 7: Programming Timer as Timer and Timer as Counter
- 8. Experiment 8: Programming Timer to perform capture operation and match facility of timer
- 9. Experiment 9: Programming PWM and application of it
- 10. Experiment 10: Programming ADC and DAC
- 11. Experiment 11: Programming UART
- 12. Experiment 12: Programming RTC and WDT
- 13. Experiment 13: Study of complex algorithm implementation for application development
- 14. Mini-Project

Textbooks						
1	NXP, LPC 2148 / 1768 data sheet, NXP inc.,					
2	NXP, LPC 2148 / 1768 user manual, NXP inc.,					
3	Development board / Kit reference manual					
	References					
1	Sloss Andrew N, Symes Dominic, Wright Chris, "ARM System Developer's Guide: Designing					
1	and Optimizing", Morgan Kaufman Publication					
2	Joseph Yiu, "The Definitive Guide to ARM® Cortex®-M3 and Cortex®-M4 Processors",					
2	Newnes; 3rd edition					
3	Technical references and user manuals of respective controller					

	Useful Links
1	https://nptel.ac.in/
2	https://in.coursera.org/
3	https://www.nxp.com/
4	https://www.arm.com/

						CO-P	O Map	ping						
]	Progra	mme C)utcom	es (PO)				PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3				2									2
CO2		3												2
CO3			3									3		2
					1: L	ow, 2: 1	Mediun	n, 3: Hi	gh					

There are three components of lab assessment, LA1, LA2 and Lab ESE. LA1 and LA2 shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be through quizzes, assignments, mini project, lab based activity and submission. Also small weightage is also given to attendance.

IMP: Lab ESE is a separate head of passing. (min 40 %), LA1+LA2 should be min 40%

Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

				ded Autonomous Ins. Y 2022-23		
				e Information		
D						
Program			Third Year B. T	onics Engineering)		
Class, 2 Course	Semester		6EN353	ech., Sem v		
Course				niastian Enginagui	nalah	
		4	-	nication Engineeri	-	
Desired	l Requisi	ites:	Analog Comun	ication Engineerin	g	
Т	eaching	Scheme		Examination	Scheme (Marks)	
Practic		2 Hrs/ Week	LA1	LA2	Lab ESE	Total
Interac			30	30	40	100
				Cı	redits: #	
		1	1			
			Cour	se Objectives		
1	To analy	se the significat			ital communications.	
2						
3						
4		Comme			T1	
Δt the e	end of the		dents will be able	with Bloom's Ta	xonomy Level	
CO1				Demodulation sche	emes	Analyz
			& Channel Codi			Evaluat
CO3						
CO4						
T I I I I	T T A 4		ist of Experimen	nts / Lab Activitie	s/Topics	
	Lab Acti	tion to MATLA	D			
1.					the mean and varian	a of the
			i normai random	variables, also find	I LIE IIEAII AIIU VALIAII	
		ion using MAT		variables, also find		
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	Useful Links
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	*		LA2 and Lab ESE. %), LA1+LA2 should be min 40%	
Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

AY 2023-24 Course Information Programme B. Tech. (Electronics Engineering) Class, Semester Third Year B. Tech., Sem-V Course Code GPN341 Course Name Mini Project-1 Desired Requisites: ECAD-I, ECAD-II, Microcontroller Interfacing and Peripherals Teaching Scheme Examination Scheme (Marks) Practical 2 Hrs/ Week LA1 LA2 Lab ESE Total Interaction - Course Objectives To provide students hands on experience on, troubleshooting, maintenance, fabrication, innovation record keeping, documentation etc. thereby enhancing the skill and competency pari of technical eduction. Course Outcomest (CO) with Bloom's Taxonomy Level To include innovative thinking and practice based learning and thereby preparing students for their final year project. Course Outcomes (CO) with Bloom's Taxonomy Level At the end of the course, the students will be able to, CO2 Construction, and debugging of an elec			Wale		e of Engineerin		
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	Useful Links
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						CO-P	O Map	ping						
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	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3	3								2	2			2
CO2			3		2									
CO3			3		2						1		1	1
CO4		2							3	3				
The stre	ngth of	mappi	ng is to	be wri	tten as	1,2,3; v	where, 1	: Low,	2: Mec	lium, 3	High			

Each CO of the course must map to at least one PO, and preferably to only one PO.

AssessmentThere are three components of lab assessment, LA1, LA2 and Lab ESE.IMP: Lab ESE is a separate head of passing.(min 40 %), LA1+LA2 should be min 40%

Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

			AY	2023-24					
			Course	Information					
Progra	amme		B.Tech. (Electro	nics Engineering)					
Class,	Semester	•	Third Year B. Te	ech., Sem V					
Cours	e Code		6EN311						
Cours	e Name		Professional Elec	ctive I -Biomedical	Instrumentation				
Desire	ed Requis	ites:	Electronics Mea	surement and Instru	umentation				
	Teaching			Examination Scheme (Marks)					
lectu	-	3 Hrs/week	MSE	ISE	ESE	Total			
futor	ial	-	30	20	50	100			
				Cre	dits: 3				
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<u>1</u> 2			dy cell structure ar	nd different types of	or transaucers				
$\frac{2}{3}$				Medical instrumen	its				
4			medical instrume		113				
-	10 denix			vith Bloom's Taxo	onomy Level				
At the	end of the		lents will be able to						
C O1	Underst	and CNS-PNS a	nd Cardio pulmon	ary system		Understan			
C O2			sensing biomedic	al signals to biome	edical	Apply			
C O3		entation setup ECG,EEG and E	MGamplifier			Create			
$\frac{CO3}{CO4}$				ring systems, X-ra	av machine. CT	Understand			
		l Ultrasonograph		,	,				
	la		Madula	0 4 4		1			
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Modu		domentals of M		Contents tation		Hours			
Modu	Fund		edical Instrumen	tation	edical signals. Basic	Hours			
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I II III	Fund Phys Med Wire of M Ele Per Ele syste Patio Sys Cer Ter Meas Mod X-r Nuo Ultra Card	iological System ical Instrumenta eless Connectivit dedical Instrumer Origin of Bio p ctrical activity ipheral Nervou ctroencephalogra em, Biomedical se ent Monitoring tem Concepts, ntral Monitors, nperature, surement of resp ern Imaging S ay machines A clear Medical Ir isonic Imaging S sting and Thera iac Pacemakers,	edical Instrumen ns of the body, tion system, Micr y in Medical Inst ntation Systems potentials, Bio po of Excitable Co sSystem,Electroca am(EEG), Electroca am(EEG), Electroca signal Analysis and Systems Cardiac Monitor, Measurement viration Rate, Bion ystems nd Digital Radiog naging Systems, N Systems and Thern apeutic Equipment	tation Sources of Biome ro-Electro-Mechani ruments, General (otential Electrodes ells, Functional (rrdiogram(ECG),El retinogram(ERG) a d Processing Techn Bedside patient 1 of Heart rate, nedical Telemetry S graphy, X-ray Con Magnetic Resonanc mal Imaging System	ical System (Mems), Constraints in design & Biosensors Drganization of the ectromogram(EMG), and their recording niques. Monitoring Systems, Measurement of Systems nputed Tomography, re Imaging Systems,	8 4 4			
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1	John. G. Webster, "Medical Instrumentation", John Wiley, 2009
2	Goddes& Baker, "Principles of Applied Biomedical Instrumentation", John Wiley, 2008
3	Carr & Brown, "Biomedical Instrumentation & Measurement", Pearson, 2004
4	
	References
1	R.S. Khandpur, "Hand book of Medical instruments", TMH, New Delhi, 1987.
2	Sanjay Guha,"Medical Electronics and Instrumentation", University Publication, 200.
3	Edwand J. Bukstein, "Introduction to Biomedical electronics", Sane and Co. Inc, 1973
4	
	Useful Links
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						CO-PC) Mapp	oing						
				I	Program	mme C	utcom	es (PO)				PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3												2	
CO2					3	2							2	
CO3			3										2	
CO4									3				2	
The streng	gth of r	napping	g is to b	be writt	en as 1	: Low,	2: Med	ium, 3:	High					
Each CO	of the c	course r	nust m	ap to at	least o	one PO.								

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

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		W		ge of Engineerii ided Autonomous Insti		
			,	Y 2023-24	····· /	
			Cour	se Information		
Progra	mme		B.Tech. (Electron	ics Engineering)		
Class,		ter	Third Year B. Tec	e e ,		
Course			6EN312			
				tive-I: Microelectron	ics	
Desire						
Desired	u Keq	uisites:	-			
Та	o ohim	- Cahama		Enomination S	ahama (Manka)	
		g Scheme	MCE	Examination Sector		T 4 1
Lectur		3 Hrs/week	MSE	ISE	ESE	Total
Tutoria		-	30	20	50	100
Practic		-				
Interac	ction	-		Cred	its: 3	
			Cou	rse Objectives		
1					sting semiconductor de	vices to give
1		<u> </u>	lies of electronic cir	2		
					e basis of energy ban	
2	Boltz devic		equation which for	rms the basis of elec	trical characteristics of s	semiconducto
			trin students to los	m on their own che	ut the next recenched d	arriana an that
3					ut the new researched d dation for of their a c	
3		ing and self ed		c and lay the foun		Silstant Caree
4				der to motivate them	for higher studies	
• 1	10 pr	<u> </u>) with Bloom's Tax	~	
At the	end of		students will be ab			
					lepletion-diffusion layer	Understand
CO1	capac	itance in p-n j		characteristics of i	luminated p-n junction,	
	Appl	y continuity e	quation and Poisso	n's equation to deri	ve time dependence of	Apply
CO2			n on electric fields			1 PP-J
		n junction in eq		and potentials by co	nsidering band diagram	i i i ppij
CO3		I the energia				
ĺ				on transistor in three	regions (cut-off, linear	
CO4	-	aturation) using	n of bipolar junction g Ebers Moll coupled diagram and expla	n transistor in three d diode model.		Apply
CO4	emitte	aturation) using yze BJT band er injection effi	n of bipolar junction g Ebers Moll couple diagram and expla ciency.	on transistor in three ad diode model. ain current gain, ba	regions (cut-off, linear	Apply Analyze
CO4 CO5	emitter	aturation) using yze BJT band er injection effi pret C-V char	n of bipolar junction g Ebers Moll couple diagram and expla- ciency. acteristics of MOS	on transistor in three ad diode model. ain current gain, ba capacitor and I-V	regions (cut-off, linear se transport factor, and	 Apply Analyze Evaluate
	emitter Inter MOS	aturation) using yze BJT band er injection effi pret C-V char	n of bipolar junction g Ebers Moll couple diagram and expla- ciency. acteristics of MOS	on transistor in three ad diode model. ain current gain, ba capacitor and I-V	regions (cut-off, linear se transport factor, and characteristics of JFET,	 Apply Analyze Evaluate
CO5	emitte Inter MOS voltag	aturation) using yze BJT band er injection effi pret C-V char FET with relev	n of bipolar junction g Ebers Moll couple diagram and expla- ciency. acteristics of MOS rance to their ethical	on transistor in three ed diode model. ain current gain, bas capacitor and I-V l parameters like pine	regions (cut-off, linear se transport factor, and characteristics of JFET,	Apply Analyze Evaluate
	emitte Inter MOS voltag	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc.	n of bipolar junction g Ebers Moll couple diagram and expla- ciency. acteristics of MOS rance to their ethical Mod	on transistor in three ad diode model. ain current gain, ba capacitor and I-V l parameters like pind ule Contents	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold	 Apply Analyze Evaluate
CO5	emitte Inter MOS voltag	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a	n of bipolar junction g Ebers Moll couple diagram and expla- ciency. acteristics of MOS rance to their ethical Mod nd Charge Carrier	on transistor in three ad diode model. ain current gain, bas capacitor and I-V l parameters like pine ule Contents rs in Semiconductor	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold	 Apply Analyze Evaluate
CO5	emitte Inter MOS voltag	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a onding forces	n of bipolar junction g Ebers Moll couple diagram and expla- ciency. acteristics of MOS ance to their ethical Mod nd Charge Carrien and energy bands in	on transistor in three ad diode model. ain current gain, bas capacitor and I-V l parameters like pine ule Contents rs in Semiconductor n solids, Charge car	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold rs riers in semiconductors,	Apply Analyze Evaluate Hours
CO5 Modul	emitte Inter MOS voltag	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a onding forces a arrier concentra	n of bipolar junction g Ebers Moll coupled diagram and expla- ciency. acteristics of MOS ance to their ethical Mod nd Charge Carrient and energy bands in ation, drift of carrie	on transistor in three ad diode model. ain current gain, bas capacitor and I-V l parameters like pine ule Contents rs in Semiconductor n solids, Charge car	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold	Apply Analyze Evaluate Hours
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CO5 Modul	emitto Inter MOS voltaş le E Ba Ca of E D	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a onding forces a arrier concentra Fermi level at xcess Carriers iffusion of ca	n of bipolar junction g Ebers Moll coupled diagram and expla- ciency. acteristics of MOS rance to their ethical Mod nd Charge Carrient and energy bands in ation, drift of carrie equilibrium. in Semiconductor rriers, Diffusion carrie	on transistor in three ad diode model. ain current gain, back capacitor and I-V l parameters like pine ule Contents rs in Semiconductor n solids, Charge car rs in electric and ma s urrent, Drift curren	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold rs riers in semiconductors, gnetic fields, invariance	 Apply Analyze Evaluate Hours 6
CO5 Modul I	emitto Inter MOS voltag	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a onding forces a arrier concentra Fermi level at xcess Carriers iffusion of ca ecombination,	n of bipolar junction g Ebers Moll coupled diagram and expla- ciency. acteristics of MOS ance to their ethical Mod nd Charge Carrient and energy bands in ation, drift of carrie equilibrium. in Semiconductor rriers, Diffusion con Continuity equatio	on transistor in three ad diode model. ain current gain, back capacitor and I-V l parameters like pine ule Contents rs in Semiconductor n solids, Charge car rs in electric and ma s urrent, Drift curren n, Quasi Fermi lev	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold rs riers in semiconductors, gnetic fields, invariance	 Apply Analyze Evaluate Hours 6
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CO5 Modul I	emitto Inter MOS voltaş le E Be Ca of E D Re Fo S	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a onding forces a arrier concentra Fermi level at xcess Carriers iffusion of ca ecombination, ermi levels, res inctions prmation of p-	n of bipolar junction g Ebers Moll coupled diagram and expla- ciency. acteristics of MOS rance to their ethical Mod nd Charge Carrien and energy bands in ation, drift of carrie equilibrium. in Semiconductor rriers, Diffusion cur Continuity equation istivity of materials.	on transistor in three ad diode model. ain current gain, back capacitor and I-V l parameters like pind ule Contents rs in Semiconductor n solids, Charge car rs in electric and ma s urrent, Drift curren n, Quasi Fermi leve	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold rs riers in semiconductors, gnetic fields, invariance t, Mobility of carriers, els, Gradients in Quasi	 Apply Analyze Evaluate Hours 6 6 8
CO5 Modul I	emitta Inter MOS voltag le E Ba CC of E D Ra Fa Fa Ju	aturation) using yze BJT band er injection effi pret C-V char FET with relev ge etc. nergy Bands a onding forces a arrier concentra Fermi level at xcess Carriers iffusion of ca ecombination, ermi levels, res inctions ormation of p- ransient and	n of bipolar junction g Ebers Moll coupled diagram and expla- ciency. acteristics of MOS rance to their ethical Mod and Charge Carrien and energy bands in ation, drift of carrie equilibrium. in Semiconductor rriers, Diffusion carrier Continuity equation istivity of materials. on junctions, Equili- AC conditions,	on transistor in three ad diode model. ain current gain, back capacitor and I-V l parameters like pind ule Contents rs in Semiconductor n solids, Charge car rs in electric and ma s urrent, Drift curren n, Quasi Fermi leve	regions (cut-off, linear se transport factor, and characteristics of JFET, ch off voltage, threshold rs riers in semiconductors, gnetic fields, invariance t, Mobility of carriers, els, Gradients in Quasi	 Apply Analyze Evaluate Hours 6 6 8
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V	Bipolar Junction Transistors Minority carrier distributions and terminal currents, Generalized Biasing: The Coupled-Diode Model, Charge control analysis; switching, drift in base region, base narrowing, avalanche breakdown, thermal effects, Kirk effect.	7
VI	Optoelectronic DevicesPhotodiodes: I-V characteristics in an illuminated junction, Solar Cells,Photodetectors; LEDs, Semiconductor Lasers.	6
	Text Books	
1	B.G. Streetman, S. K. Banerjee, "Solid State Electronic Devices ", 7th edition, Pear Education Service Pvt. Ltd., 2017.	rson India
2		
3		
4		
	References	
1	S. M. Sze, "Physics of Semiconductor Devices", 2 nd Edition, PHI, 2005.	
2	Donald. A. Neamen, "Semiconductor Physics and Devices: Basic Principles", 3rd	¹ Edition,
2	McGraw Hill Higher Education, 2003.	
	Useful Links	
1	https://nptel.ac.in/courses/108/107/108107142/	
2	https://www.youtube.com/playlist?list=PLF178600D851B098F	
3	https://www.youtube.com/playlist?list=PLgMDNELGJ1CaNcuuQv9xN07ZWkXE-wCG	θP
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					(CO- P() Map	ping						
				1	Program	mme C	outcom	es (PO)				PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	2													1
CO2	3													1
CO3	3	2												
CO4	3	2												
CO5	2	2												1
The stren	gth of r	nappin	g is to l	be writt	ten as 1	: Low,	2: Med	ium, 3:	High					
Each CO	of the c	course	must m	ap to a	t least c	one PO.								

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

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		Walc	hand College (Government Aided	of Engineerin d Autonomous Institu			
				2023-24			
			Course 2	Information			
Progra	mme		B.Tech. (Electron	e			
· · · ·	Semester		Third Year B. Te	ech., Sem V			
Course			6EN313				
Course				tive 1 - Linear Alg	ebra		
Desire	d Requisi	tes:	Applied Mathem	natics I & II			
r	Feaching	Scheme		Examination	Scheme (Marks)		
Lectur	0	3 Hrs/week	MSE	ISE	ESE	Total	
Tutoria		-	30	20	50	100	
1 40011				-	dits: 3		
			Course	Objectives			
1			understanding of]	-	tions, Matrix algebr	a, Vector spa	ace,
2		oduct of vector			· · · · · · · · · · · · · · · · · · ·		
					counting problems orks, Control system		uter
3	graphics.		of Ellieur Angeoru			ilo una compe	ater
4							
A / /1	1 0.1		Outcomes (CO) w		onomy Level		
At the c	end of the Describ	course, the stuc	lents will be able to atrix algebra rules,), vector space inne	er product space	Underst	tand
COI	Eigen v	alues and Eiger	n vectors.			Underst	lanu
CO2			equations, inner pr	roduct space proble	ems, problems of	Appl	y
CO3	Eigen v	alues and Eiger e linear algeb	ra techniques to el	ectrical and electro	onics circuits and	Appl	v
000			Transformations 1			· · · PP·	. 9
CO4							
Madul			Madula	Contonta		Hour	
Modu		tems of Linear		Contents		Hour	rs
			combinations, Solv	ving systems of line	ear equations.		
Ι	Ech	elon and reduce	d echelon form, Ma	atrices, Elimination	n using matrices,	4	
1			rations, the inverse	of a matrix, charac	terization of	4	
		rtible matrix,	atrix factorization				
		tor Spaces	natrix factorization				
TT	Vec	tor spaces and s			w spaces, Dual space	e, o	
II	tran	sformations, lin	early independent	sets, bases and dir	nension, coordinate	8	
			s to Electrical circu	its and data smoo	othing		
		er product of ` oth and dot prod	vector Spaces luct in R ⁿ , Inner pr	oduct Spaces			
III					cal models and Lea	st 8	
	squar	es analysis, App	lications of Inner p				
		ear Transform				_	
IV					near Transformatio	n, 8	
		en values and	the Pseudo-inverse Eigen vectors	2			
			gen vectors, charac	teristic equations,	linear		
V	tran	sformations,dig	onilzations, Applic			7	
		plex Eigen val	ues,				
	orthg	onality					

VI	ApplicationsMatrices in engineering, ,single value decomposition, Computer Graphics,4
	Leastsquares approximation.
	Textbooks
1	Gilbert Strang, Wellesley-Cambridge, "Introduction to Linear Algebra"5 th edition, Press, 2016
2	Jim Defranza and Daniel Gagliardi,"Introduction to Linear Algebra with Applications" McGraw Hill Education (India) Edition 2012
3	Stephen Boyd and Lieven Vandenberghe, "Introduction to Applied Linear Algebra", CambridgeUniversity Press, 2018
4	
	References
1	Ward Cheney and David Kincaid, Jones, "Linear Algebra Theory and Applications and Bartlett", Publishers, Indian Edition 2010
2	David C. Lay, Steven R. Lay, and Judi J., "Linear Algebra and its Applications" McDonald, Pearson, 5 edition, 2015
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	Useful Links
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3	
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						CO-PC) Mapp	oing						
				I	Program	mme C	utcom	es (PO)				PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1		3												1
CO2	3	3												1
CO3	3													1
CO4														
The streng	gth of r	nappin	g is to b	be writt	en as 1	: Low,	2: Med	ium, 3:	High					
Each CO	of the c	ourse 1	nust m	ap to at	t least o	one PO.								

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					of Engineerin l Autonomous Institu					
					2023-24					
					Information					
Progr				B.Tech. (Electron	e					
Class,				Third Year B. Te	ch., Sem V					
Cours				6EN314						
Cours				Automotive Elec	tronics					
Desire	ed Ro	equisites:								
	Tea	ching Sche	me		Examination	Scheme (Marks)				
Lectu	re	3 H	Irs/week	MSE	ISE	ESE	Total			
Tutor	ial		-	30	20	50	100			
					Cre	dits: 3				
				Course	Objectives					
1	To	learn the b	asic control	system and sensor	0	control				
2										
3				al conversion circuit in Automotive system						
4										
				Outcomes (CO) w		onomy Level				
				ents will be able to	,		TT 1 . 1			
<u>CO1</u>				n to control engine		4	Understand			
CO2 CO3				munication to dev		ts for engine control	Apply			
05		trumentatio		identify the comp	Juting requirement	its for engine control	Analyze			
Modu	مار			Module	Contents		Hours			
Mout		The Basic	s of Flectro	nic Engine Cont			110015			
				0		ions, Fuel Economy,				
				•		tronic Engine Control				
Ι				Engine Performation			8			
		-		c Fuel Control Sys		•				
				Control, Electroni	•					
			nd Actuato		~		<u> </u>			
					s of Sensors and A	Actuators, Throttle				
				rature Sensors, T						
TT		-	-		-	LIDAR, Digital	0			
II		Video Can	nera, Flex-l	Fuel Sensor, Auto	motive Engine Co	ontrol Actuators,	8			
		Variable V	alve Timin	g, Electric Motor	Actuators, Steppe	er Motors, Ignition				
		System								
		Digital Po	wertrain C	ontrol Systems						
		0		•	for Fuel Control,	Discrete Time Idle				
	1)					
717		Speed Con		Control, Variable	Valve Timing Co	ntrol, Turbocharging,	7			
III		-	trol, EGR	Control, Variable Flex Fuel, Electr	-		7			

	Vehicle Motion Controls	
	Representative Cruise Control System, Cruise Control Electronics, Antilock	
IV	Braking System, Electronic Suspension System, Electronic Suspension	4
	Control System, Four-Wheel Steering CAR	
	Automotive Instrumentation	
	Modern Automotive Instrumentation, Input and Output Signal Conversion,	
V	Display Devices, Fuel Quantity Measurement, Coolant Temperature	4
	Measurement, Oil Pressure Measurement, Vehicle Speed Measurement,	
	Vehicle Communications	
	IVN, CAN, Local Interconnect Network (LIN), FlexRay IVN, MOST IVN,	
VI	Vehicle to Infrastructure Communication, Vehicle-to-Cellular Infrastructure,	8
V I	Short-Range Wireless Communications, Satellite Vehicle Communication,	0
	GPS Navigation, Safety Aspects of Vehicle-to-Infrastructure Communication	
	Textbooks	ative?
1	William Ribbens, "Understanding Automotive Electronics An Engineering Perspective Elsevier	ective
1	Elsevier	
2	Bosch Automotive, Robert Bosch GmbH "Electrics and Automotive Electronics	: Systems and
2	Components, Networking and Hybrid Drive", Springer Science & Business Medi	a, 2013
3		
4		
	References	
1	Najamuz Zaman, "Automotive Electronics Design Fundamentals", Springer C 2016	ham, October
2	Ronald K. Jurgen ,"Automotive Electronics Handbook", McGraw Hill Profession	al, 1999
3		
4		
	Useful Links	
1		
2		
3		
4		

					(CO-PC) Mapp	oing						
				I	Progra	mme C	outcom	es (PO)				PS	50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1				3										
CO2				3										
CO3				3										
CO4														
The streng	gth of r	napping	g is to b	be writt	en as 1	: Low,	2: Med	ium, 3:	High					
Each CO	of the c	ourse 1	nust m	ap to at	t least o	one PO.								
	•		-					ium, 3:	High	1	1	1	1	

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

			(Government Aided Ai AY 202		· ·	
			Course Inf			
Progr	amme		B.Tech. (Electronics	s Engineering)		
	Semester		Third Year B. Tech.			
	e Code		6EN315			
Cours	e Name		Professional Elective	e II - Object O	riented Programming	
Desire	ed Requisi	tes:	C Programming			
			<u> </u>			
	Teaching	Scheme		Examination	Scheme (Marks)	
Lectu	re	2 Hrs/week	MSE	ISE	ESE	Total
Tutor	ial	1 Hr/week	30	20	50	100
				Cr	edits: 3	
			Course Ol	bjectives		
1	To introd	uce the students	the concepts of object	ct oriented pro	gramming	
2	To explai	n and illustrate	the fundamental conce	epts of classes,	objects, facilities in OC	OP etc.
3	· · ·		the concepts of opera			
4	To explai		the concepts of inher			
A 4 41a a	and of the		Outcomes (CO) with ents will be able to,	Bloom's Tax	onomy Level	
$\frac{\text{At the}}{\text{CO1}}$			g (of OOP) to identi	fy how the pro	blem can be solved	Apply
COI	using O	OP approach (f	or a given situation).			Арргу
CO2	Apply t	he knowledge o	of OOP to illustrate the	he functioning	of OOP facilities	Apply
CO3		related program	ns. program and identify	the functional		Analyza
$\frac{CO3}{CO4}$			brary for electronic p		ity.	Analyze Evaluate
	Lvaluate			empherals		Lvaluat
Modu	ıle		Module C	ontents		Hours
	OOP	Programming	Fundamentals			
Ι			nted programming, D			5
		I I / I	1 / /		conversion, library and	
-			n of C type construct			
	Ohio	lerfiles, Revision		s in CPP		
		cts and Classes			ects, class and data	
II	Nee	ets and Classes d of class, real l	ife examples of class,	, class and obj	ects, class and data constructor, destructor,	4
	Nee type defa	ets and Classes d of class, real l s, access specif ultconstructor,	ife examples of class, ers, objects as function copy constructor, sco	class and objourn of arguments,		4
	Nee type defa Oper	ets and Classes d of class, real l s, access specif ultconstructor, ator Overload	ife examples of class, ers, objects as functio copy constructor, sco ng	class and objour arguments, pe resolution,	constructor, destructor, UML diagram of class	
	Nee type defa Oper Need	ts and Classes d of class, real l s, access specif ultconstructor, ator Overload of Operator ov	ife examples of class, ers, objects as function copy constructor, sco ng erloading, Overloadir	class and objoin arguments, per resolution, ng unary operation,	constructor, destructor, UML diagram of class ators, Overloading binar	y A
II	Nee type defa Oper Need opera	ts and Classes d of class, real l s, access specifi ultconstructor, ator Overload of Operator ov tors, data conv	ife examples of class, ers, objects as function copy constructor, sco ng erloading, Overloadin ersion between objec	class and objoin arguments, per resolution, ng unary operation,	constructor, destructor, UML diagram of class	y A
II	Nee type defa Oper Need opera overla	ts and Classes d of class, real l s, access specif ultconstructor, ator Overloadi of Operator ov tors, data conv bading and conv	ife examples of class, ers, objects as functio copy constructor, sco ng erloading, Overloadir ersion between objec version	class and objoin arguments, per resolution, ng unary operation,	constructor, destructor, UML diagram of class ators, Overloading binar	y A
II III	Nee type defa Oper Need opera overle Inher Base	ts and Classes d of class, real l s, access specif ultconstructor, ator Overload of Operator ov tors, data conv bading and conv itance and Po class and der	ife examples of class, ers, objects as function copy constructor, sco ng erloading, Overloadin ersion between object version ymorphism wed class, derived	class and objout of arguments, peresolution, peresolution, and unary operates and basic the class constructs class constructs.	constructor, destructor, <u>UML diagram of class</u> ators, Overloading binar ypes, Pitfalls of operate ctor, overriding membe	ry 4 er 5
II	Nee type defa Oper Need opera overla Inher Base functi	ts and Classes d of class, real l s, access specifi ultconstructor, ator Overload of Operator overload tors, data convert oading and convert itance and Poor class and der ons, abstract b	ife examples of class, ers, objects as function copy constructor, scoon ng erloading, Overloadin ersion between object version ymorphism ived class, derived ase class, class hier	class and objout arguments, operasolution, peresolution, and unary operates and basic to class construct archy, public	constructor, destructor, UML diagram of class ators, Overloading binar ypes, Pitfalls of operato ctor, overriding member and private inheritanc	ry 4 er 5
Ш	Nee type defa Oper Need opera overle Inher Base functi avoid	ts and Classes d of class, real l s, access specifi ultconstructor, ator Overloadi of Operator ov tors, data convi- oading and convi- bading and convi- class and der ons, abstract b- ing ambiguity o	ife examples of class, ers, objects as function copy constructor, scoon g erloading, Overloadin ersion between object version ymorphism wed class, derived ase class, class hier f multiple inheritance	class and objout arguments, operasolution, peresolution, and unary operates and basic to class construct archy, public	constructor, destructor, UML diagram of class ators, Overloading binar ypes, Pitfalls of operato ctor, overriding member and private inheritanc	ry 4 er 5
Ш	Nee type defa Oper Need opera overle Inher Base functi avoid Point	ts and Classes d of class, real l s, access specif ultconstructor, ator Overload of Operator overload ove	ife examples of class, ers, objects as function copy constructor, sco ng erloading, Overloadin ersion between object version ymorphism ived class, derived ase class, class hier of multiple inheritance I Functions	class and objout arguments, operasolution, peresolution, and unary operates and basic to class construct archy, public e, polymorphis	constructor, destructor, <u>UML diagram of class</u> ators, Overloading binar ypes, Pitfalls of operate ctor, overriding member and private inheritanc m	ry 4 er 5
II III	Need type defa Oper Need opera overlo Inher Base functi avoid Point Add	ts and Classes d of class, real l s, access specif ultconstructor, ator Overload of Operator ov tors, data convert oading and convert itance and Po class and der ons, abstract b ing ambiguity of ers and Virtua ress and pointer	ife examples of class, ers, objects as function copy constructor, sco ng erloading, Overloadin ersion between object version ymorphism wed class, derived ase class, class hier f multiple inheritance I Functions s, Pointers and arrays	class and objout arguments, peresolution, peresolution, and unary operates and basic the class construction of the class c	constructor, destructor, <u>UML diagram of class</u> ators, Overloading binar ypes, Pitfalls of operate ctor, overriding membra and private inheritance m	ry 4 er 5
II III IV	Need type defa Oper Need opera overla Inher Base functi avoid Point Add men	ts and Classes d of class, real l s, access specif ultconstructor, ator Overload of Operator ov tors, data conv bading and conv itance and Po class and der ons, abstract b ing ambiguity of ers and Virtua ress and pointer nory manageme	ife examples of class, ers, objects as function copy constructor, sco ng erloading, Overloading ersion between object version ymorphism wed class, derived ase class, class hier of multiple inheritance I Functions rs, Pointers and arrays nt using new and derived	class and objout of arguments, peresolution, peresolution, and unary operates and basic the class construction of the clas	constructor, destructor, UML diagram of class ators, Overloading binar ypes, Pitfalls of operate ctor, overriding membrand and private inheritanc m functions, strings, ons of pointers, Virtua	y 4 er 5
II III IV	Nee type defa Oper Need opera overla Inher Base functi avoid Point Add men func	ts and Classes d of class, real l s, access speciful ultconstructor, ator Overloadi of Operator overloadi overloading and converloading and converloading and converloading class and der ons, abstract be ing ambiguity of ers and Virtua ress and pointer ory managementions, friend fund	ife examples of class, ers, objects as function copy constructor, scoon g erloading, Overloadin ersion between object version ymorphism ived class, derived ase class, class hier of multiple inheritance I Functions s, Pointers and arrays nt using new and de ctions, static function	class and objourners, operation arguments, operation, per resolution, and unary operates and basic the class construction of the class construction	constructor, destructor, UML diagram of class ators, Overloading binar ypes, Pitfalls of operate ctor, overriding membrand and private inheritanc m functions, strings, ons of pointers, Virtua	y 4 er 5
II III IV	Nee type defa Oper Need opera overle Inher Base functi avoid Point Add men func	ts and Classes d of class, real l s, access specif ultconstructor, ator Overloadi of Operator ov tors, data conve- bading and conve- bading and conve- bading and conve- tiance and Po class and der ons, abstract b ing ambiguity of ers and Virtua ress and pointer bory manageme tions, friend fun g OOP for em	ife examples of class, ers, objects as function copy constructor, scoon gerloading, Overloadin ersion between object version ymorphism wed class, derived ase class, class hier of multiple inheritance I Functions s, Pointers and arrays in using new and de ctions, static function pedded electronic system	class and objourners, operation arguments, operation, peresolution, and unary operates and basic the class construct archy, public e, polymorphise, pointers and elete, applications, this pointer stems	constructor, destructor, UML diagram of class ators, Overloading binar ypes, Pitfalls of operate ctor, overriding membrand and private inheritanc m functions, strings, ons of pointers, Virtua	^{ry} 4 er 5 1 4

1	Robert Lafore, "Object Oriented Programming in C++", SAMS publishing, Fourth Edition, ISBN: 0-672-32308-7. (If needed the relevant language book will be referred)
2	Arduino Library related Internet resources
3	
4	
	References
1	Bjorne Stroustrup, "The C++ programming language", 4th Edition, Addison-Wesley Professional, ISBN: 978-0321563842
2	Web tutorials C++ and Object Oriented Programming
3	NPTEL lectures, Object-Oriented Programming by IITBx (free audit course)
4	Arduino Library related Internet resources
	Useful Links
1	
2	
3	
4	

CO-PO Mapping														
	Programme Outcomes (PO)												PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3												3	
CO2			2											2
CO3		3											3	
CO4			3											3
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													

Each CO of the course must map to at least one PO.

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Walc		of Engineering								
			•	2023-24	,							
			Course I	nformation								
Progra	amme		B.Tech. (Electron	ics Engineering)								
Class,	Semester		Final Year B. Tec									
Cours	e Code		6EN316									
Cours	e Name		Data Analytics									
Desire	d Requisi	tes:	Probability and Statistics									
	-		y									
	Teaching	Scheme		Examination S	cheme (Marks)							
Lectur	0	3 Hrs/week	MSE	ISE	ESE	Т	otal					
Tutori	ial	-	30 20 50									
				Cred	its: 3							
			Course	Objectives								
1	Develop	in depth underst		•	science and busine	ss anal	vtics:					
-	 Develop in depth understanding of the key technologies in data science and business and Use quantitative modeling and data analysis techniques to the solution of real world bus 											
2	problems, communicate findings, and effectively present results using data visualization											
	techniques											
3												
4		~										
A / 1	1 0 1		· /	ith Bloom's Taxor	nomy Level							
At the CO1	1	· · · · · · · · · · · · · · · · · · ·	ents will be able to s of data analytics	,								
$\frac{CO1}{CO2}$				nniques on streamir	na data							
$\frac{CO2}{CO3}$				attern mining algor								
CO4	· · · · · ·			<u> </u>	cs on Big data using	g R						
	1	i			8	8						
Modu	le		Module	Contents			Hours					
	Intro	duction to Data	Analytics: Source	es and nature of dat	a, classification of o	lata						
	(strue	ctured, semi-stru	ctured, unstructure	d), characteristics	of data, introductio	n to						
					of analytic scalabi							
Ι	-		· •	s reporting, mode	rn data analytic to	ols,	5					
		cations of data an		rolog for guagas	sful analytic proje	ata						
					ata preparation, m							
				ig results, operation								
		Analysis	<u> </u>	- /1								
	Reg	ression modeling			odeling, inference							
					analysis of time ser		-					
II					ction, neural netwo		8					
					al component anal							
			stic search methods		dels from data, fu	izzy						
		ng Data Stream										
		eam										
TTT		Introduction to streams concepts, stream data model and architecture, s computing, sampling data in a stream, filtering streams, counting distinct ele										
III	in a stream, estimating moments, counting oneness in a window, decaying											
				RTAP) application								
			is, stock market pr		,	1						

IV	Frequent Itemsets and Clustering Mining frequent itemsets, market based modelling, Apriori algorithm, handling large data sets in main memory, limited pass algorithm, counting frequent itemsets in a stream, clustering techniques: hierarchical, K-means, clustering high dimensional data, CLIQUE and ProCLUS, frequent pattern based clustering methods, clustering in non-euclidean space, clustering for streams and parallelism.	7
V	Frame Works and Visualization MapReduce, Hadoop, Pig, Hive, HBase, MapR, Sharding, NoSQL Databases, S3, Hadoop Distributed File Systems, Visualization: visual data analysis techniques, interaction techniques, systems and applications	7
VI	Introduction to R R graphical user interfaces, data import and export, attribute and data types, descriptive statistics, exploratory data analysis, visualization before analysis, analytics for unstructured data	5
	Textbooks	
1	Rechard Dosey, "Data Analytics: Become A Master In Data Analytics Paperback"	
2	Mark Gardner, "Beginning R: The Statistical Programming Language", Wrox Public	cation
3		
4		
	2.4	
	References	·
1	David Dietrich, Barry Heller, Beibei Yang, "Data Science and Big Data Analyt Education Series, John Wiley	nes", EMC
2	Michael Berthold, David J. Hand, Intelligent Data Analysis, Springer	
3	Anand Rajaraman and Jeffrey David Ullman, Mining of Massive Datasets, University Press	Cambridge
4		
	Useful Links	
1		
2		
3		

	CO-PO Mapping													
		Programme Outcomes (PO)												
	1 2 3 4 5 6 7 8 9 10 11 12												1	2
CO1	3		3											
CO2														
CO3				3										3
CO4	3				3									
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO of the course must map to at least one PO.														

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

For passing a theory course, Min. 40% marks in (MSE+ISE+ESE) are needed and Min. 40% marks in ESE are needed. (ESE shall be a separate head of passing)

		Walc	hand College	of Engineering								
			·	2023-24	,							
				nformation								
Progra	mme		B.Tech. (Electron									
	Semester		Third Year B. Te									
Course			6EN317									
	e Name		Optical Commun	ication								
		tog.	Communication Engg									
Desire	d Requisi	les:	Communication	ommunication Engg								
r	F 1 •	G 1										
	Feaching				cheme (Marks)	T ()						
Lectur		3 Hrs/week	MSE	ISE	ESE	Total						
Tutori	al	-	30	20	50	100						
	Credits: 3											
			Course	Objectives								
1	Understa and device		signal propagation	through optical fit	bers, fiber impairmen	its, compone	ents					
2	Classify the various sources and detector for Optical link budget											
3			amplifier used in t	<u> </u>								
4	Understa		erformance for long									
	1 0 1		Outcomes (CO) w		nomy Level							
			ents will be able to	-	1 61 1							
CO1	configura	ations and struct				II						
CO2	signal De	gradation factor			wave guides and oth RI profile and cut-of		-					
~~~	wave len	<b>v</b>										
CO3	Classify			noise effects on	system performan	ICE, IV						
<b>CO4</b>			DM and solutions Il source materials,	I FD structures	untum officiency							
0.04	Laser dic	des and differen		optical receivers su	ich as PIN APD diod	es, V						
Modu	le		Module	Contents		Hou	irs					
Ι	Introd angle propa	, Numerical ap	perture, Skew rays waves, modes in F	, Electromagnetic	reflection, Accepta mode theory of opt se and group veloc	ical 7						
П	Atten Nonl transi Polar	uation, Materia inear Scattering nission, Intra a ization, non lin	losses, Fiber Bend and inter Modal ear Phenomena. C	ses in silica gla d losses, Midband Dispersion, Over Optical fiber conn	ss fibers, Linear a and farband infra all Fiber Dispersi ectors, Fiber alignm ed Beam Connectors	red ion, 7						

	Comment of Defendance	
	Sources and Detectors	
	Optical Sources : Semiconductor Physics background, Light emitting diode	
	(LEDs)- structures, materials, Figure of merits, characteristics & Modulation.	
	Laser Diodes -Modes & threshold conditions, Diode Rate equations, resonant	
III	frequencies, structures, characteristics and figure of merits, single mode lasers,	7
	Modulation of laser diodes, Spectral width, temperature effects, and Light source	
	linearity.	
	Optical Detectors: PIN Photo detectors, Avalanche photo diodes, construction,	
	characteristics and properties, Comparison of performance, Photo detector noise -	
	Noise sources, Signal to Noise ratio, Detector response time	
	Coupling and Receiver operation	
	Power Launching and Coupling: Source to fiber power launching, Lensing	
IV	schemes, fiber-to-fiber joints, LED coupling to single mode fibers, fiber splicing, Optical fiber connectors.	6
1 V		0
	Optical Receiver Operation : Receiver operation, Preamplifier types, receiver	
	performance and sensitivity, Eye diagrams, Coherent detection, Specification of	
	receivers Onticel Transmission System	
	<b>Optical Transmission System</b> Transmission Systems : Point –to-point link –system considerations, Link power	
	budget and rise time budget methods for design of optical link, BER calculation	
V	Optical Amplifiers : Semiconductor optical Amplifier, EDFA, Raman Amplifier,	6
	Wideband Optical Amplifiers	
	wideband Optical Amplificis	
	Measurements and Advances in Optical Fiber Systems	
	Fiber Attenuation measurements- Dispersion measurements – Fiber Refractive	
<b>X</b> 7 <b>X</b>	index profile measurements – Fiber cut- off Wave length Measurements – Fiber	6
VI	Numerical Aperture Measurements – Fiber diameter measurements	6
	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching	
	Principles of WDM, DWDM, Telecommunications & broadband application,	
	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching Textbooks	
1	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching	aw-Hill, 5 ^{ti}
	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra	
1	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.	
	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and	
2	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and	
2 3	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009	
2 3	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References	l Practice"
2 3	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009	l Practice"
2 3 4 1	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications". 9781316870532, 2017, Cambridge University Press	l Practice"
2 3 4	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications".	l Practice"
2 3 4 1	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications". 9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647	l Practice"
2 3 4 1 2	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications". 9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647	l Practice"
2 3 4 1 2 3	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications". 9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647	l Practice"
2 3 4 1 2 3	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications". 9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647         House optoelectronics library, 2001         Useful Links	l Practice"
2 3 4 1 2 3 4 1	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications". 9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647         House optoelectronics library, 2001	l Practice"
2 3 4 1 2 3 4 1 2	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications".         9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647         House optoelectronics library, 2001         Useful Links	l Practice"
2 3 4 1 2 3 4 1	Principles of WDM, DWDM, Telecommunications & broadband application, SONET/SDH, MUX, Analog & Digital broadband, optical switching         Textbooks         Keiser, G, "Optical Fiber Communications", ISBN - 9780071164689, by McGra Edition, 2000.         John M. Senior, M. Yousif Jamro, "Optical Fiber Communications: Principles and ISBN - 9780130326812, Prentice Hall Internacional series in optoelectronics, 2009         References         Singal, T.L, "Optical Fiber Communications: Principles and Applications".         9781316870532, 2017, Cambridge University Press         Rogers, A.J, "Understanding Optical Fiber Communications", ISBN - 97808900647         House optoelectronics library, 2001         Useful Links	l Practice"

CO-PO Mapping														
	Programme Outcomes (PO)													50
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													

CO2				3									
CO3				3									
CO4				3									
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO of the course must map to at least one PO.													

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Walc		of Engineering								
<u> </u>				2023-24								
			Course	Information								
Progra	amme		B.Tech. (Electron	nics Engineering)								
	Semester		Third Year B. Te									
· · ·	e Code		6OE357									
Cours	e Name		Introduction to E	lectronic Systems								
Desire	d Requisi	tes:	Basic Electronics	•								
	•		<u> </u>	<u> </u>								
I	Teaching	Scheme		Examination S	Scheme (Marks)							
Lectur		3 Hrs/week	MSE	ISE	ESE	L I	otal					
Tutori		_	30	20	50		100					
				-	lits: 3							
		1	1									
			Course	Objectives								
1	To illust	ate the concept		systems and its ap	plication.							
2	1.5 11450	and the concept		2, sterns and its ap								
3												
4												
			· · · · ·	vith Bloom's Taxo	nomy Level							
		· · · · · · · · · · · · · · · · · · ·	ents will be able to	,								
CO1		Explain the working of components used in the electronic systems. Understand										
CO2		Develop a digital circuit for a given logic and build circuit for given Apply										
CO3		pecifications.         Analyze           Analyze the performance of Data Acquisition System and Power Electronics         Analyze										
COS	Circuits.	the performance	e of Data Acquisi	tion System and r	ower Electronics	All	lalyze					
CO4		edded system a	oplications using A	rduino board.		A	pply					
			· · · · · ·									
Modu	le		Module	e Contents			Hours					
Ι	Trans Instru switc diode using transe	imentation Amp hes, Temperatur sensor, piezoel magnetic photo lucers, Resistive	Classification, Chan lifiers, Capacitive e sensors:RTD, tl ectric transducer pl electric pickup. Di e, Glass scales, Ma	type, Inductive typ hermistor, Thermo hotovoltaic cell, LI	couple, semiconduc DR, Speed measure nt: LVDT, capacitiv cept of Quadrature	ctor ment	7					
II	Oper Diffe amp voltag ampli	ational Amplificer rential amplifier characteristics, ge to current fiers, Active fil	ier r, Basic op-Amp o Inverting and Nor converters, curren	configuration, Idea n inverting amplif t to voltage con-	l op-amp analysis, iers, Adder, Subtra verters, instrument r application, wave	actor,	8					
III	Digit Flip-t	Digital Systems Flip-flops, Counters, Up-counters, Down Counters, Mod-N counters, State 5 diagram.										
IV	Data Digit Acqu multi	<b>Data Acquisitions System</b> Digital to Analog Converter (DAC), Analog to Digital converter (ADC), Data Acquisition System (DAS): introduction, objectives of DAS, single and multichannel, data conversion, sample and hold circuit, elements of DAS, interfacing of transducers-multiplexing.										
V	Powe SCR,	er Semiconduct TRIAC, DIAC	or Devices and its , UJT, AC voltage	Applications	lled rectifiers, Inve nics lamp ballast.	rters,	5					

VI	<b>Embedded Systems</b> Introduction to microcontroller based system: Arduino board, Arduino based systems, Simple Arduino program, interfacing display board to Arduino, Speed control of DC motor, motor driver IC: L293D.	8
	Textbooks	
1	R. Boylestad and L. Nashelsky, "Electronics Devices and Circuits", 8th Edition, Pr International, 2005.	entice Hall
2	Anand Kumar, "Fundamentals of Digital circuits", 2nd Edition, PHI, 2009.	
3	A. K. Sawhney, "Measurements and Instrumentation", Dhanpat Rai and Sons, 2013	
4		
	References	
1	R. P. Jain, "Modern Digital Design", Mc-Graw-Hill, 2008	
2	Ramakant Gaikwad, "Op-amps and Linear Integrated Circuits", Pearson Education,	2011.
3	M.D. Singh and KB Khanchandani, "Power Electronics", 2nd Edition, McGraw-Hil	l, 2007.
4		
	Useful Links	
1	www.spoken-tutorial.orgIIT Bombay.	
2		
3		
4		

	CO-PO Mapping													
				I	Progra	mme C	)utcom	es (PO	)				PSO	
	1         2         3         4         5         6         7         8         9         10         11         12											12	1	2
CO1	3													2
CO2	3		2											2
CO3		3												3
CO4	3		2											3
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO of the course must map to at least one PO.														

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Walc		of Engineerin						
				2023-24	,					
			Course	Information						
Progra	amme		B.Tech. (Electro	nics Engineering)						
Class,	Semester		Third Year B. Tech., Sem V							
Cours	e Code		6OE358							
Cours	e Name		Open Elective –	Open Elective – Signals and Systems						
Desire	ed Requisi	ites:	-							
	Teaching	Scheme		Evamination	Scheme (Marks)					
Lectu	_	3 Hrs/week	MSE	ISE	ESE ESE	Total				
Tutori		-	30	20	50	100				
1 41011				100						
					dits: 3					
			Course	e Objectives						
1	of applli	cations	al skills to solve p	roblems involving	signals and systems in					
2		To Understand signals and systems in terms of both the time and transform domains with,								
3	complen	omplementary insights into tools for analysis								
<u> </u>										
	1	Course	Outcomes (CO) y	with Bloom's Taxo	onomv Level					
At the	end of the		lents will be able t		,					
CO1			nals and systems			Understand				
CO2		haracterize LTI systems in the time domain and frequency domain Apply								
CO3				e signal processing	and system analysis	Apply				
	for diffe	rent applications	5							
Modu	ıle		Module	Contents		Hours				
112044		sification of Sig	nals and Systems							
	Stand	lard signals- Ste	ep, Ramp, Pulse, I	mpulse, Real and c	complex exponentials					
т		and Sinusoids, Classification of signals – Continuous time (CT) and Discrete								
Ι		Time (DT) signals, Periodic & Aperiodic signals, Deterministic & Random								
		signals, Energy & Power signals, Classification of systems- CT systems and DT systems, Linear & Nonlinear, Time-variant & Time-invariant, Causal &								
		Noncausal, Stable & Unstable.								
		Analysis of CT and DT signals								
II		-	-	ourier Transform -	- properties- Laplace	8				
		Transforms and properties.								
TTT		Analysis of DT signals								
III		Baseband signal Sampling – Fourier Transform of discrete time signals (DTFT) – Properties of DTFT - Z Transform & Properties								
			ant DT Systems	storm & r topernes						
TT 7				ons-Convolution s	um- Discrete Fourier	8				
IV	-	Impulse response – Difference equations-Convolution sum- Discrete Fourier Transform and Z Transform Analysis of Recursive & Non-Recursive systems-								
		DT systems connected in series and parallel.								
	1	Application areas of Signals and Systems								
V		Overview of applications of Signals and Systems in the fields of Speech and								
v	audio processing.Multimedia processing (image and v acoustic, Biological signal analysis, Biometrics, contro				· · ·	7				
		<b>`</b>	<u> </u>							
VI	Analysis of Signals and Systems using Simulation Tools									
	Introduction to MATLAB, Use MATLAB software to implement the signal									
	processing and system analysis.									

	Textbooks								
1	B.P. Lathi, "Signals, Systems & Communications"- BS Publications, 2003.								
2	A.V. Oppenheim, A.S. Willsky and S.H. Nawab,"Signals and Systems"- PHI, 2nd Edn.								
3									
4									
	References								
1	Simon Haykin and Van Veen,"Signals & Systems" -, Wiley, 2nd Edition.								
2									
3									
4									
	Useful Links								
1	NPTEL lectures								
2	https://www.mathworks.com								
3									
4									

CO-PO Mapping														
	Programme Outcomes (PO)									PS	PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													
CO2		2												
CO3					3								2	
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High														

Each CO of the course must map to at least one PO.

#### Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

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ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Wa		ge of Engineering						
				ided Autonomous Institu Y 2023-24	te)					
				rse Information						
Progr										
	Semes	ter	B.Tech. (Electronics Engineering) Third Year B. Tech., Sem-V							
	se Code		6EN354							
Cours	se Nam	e	Project Management							
Desire										
			·							
		g Scheme		Examination Sch	eme (Marks)					
Lectu		-	LA1	LA2	Lab ESE	Total				
Intera	action	2 Hour/week	30	30	40	100				
				Credits	:: 2					
	Torr	anara tha atuda		Irse Objectives	abnical and mana	anial aballances				
1	To prepare the students to manage projects by exploring both technical and managerial challenges and preparing the budget.									
2		To make aware the students about leadership and ethical qualities in dealing with real life project								
3	<b>3</b> To induce qualities for working in interdisciplinary and cross functional teams with effective communication skills, economical and managerial challenges and commercial management.									
		Cou	rse Outcomes (CC	)) with Bloom's Taxon	omv Level					
At the	end of		students will be able		v					
					Bloom's	Bloom's				
CO	Cour	rse Outcome St	tatement/s		Taxonomy Level	Taxonomy Description				
CO1	Grasp and c	Understanding								
CO2	1	Estimate and prepare budget for project completion and IV Analyz								
CO3		Figure out and schedule the project and assess for controlling V critical path networks								
				Contents						
1	Introduction to Project Management. Phases in the life cycle of projects and their significance, characteristics of projects from conventional organizations, objectives of the project and interdependence of cost on schedules									
2	4									

3	Critical Path Networks - Principles of Resource Scheduling. Numeric Models of Project, Non-Numeric Models of Project, Scoring Models of Project, Project Network and CPM, Gantt Charts, Resource allocation and Controlling phases of a project	4
4	<ul> <li>Executing and Controlling.</li> <li>Audit schedules and auditing a project and identifying deviations, quality needs in a project, applying relevant quality tools in a project and interpreting the results of the tools to monitor the quality</li> <li>Commercial Management and various regulations.</li> <li>Potential risks in a project, Categorizing of project risks, and defining the strategies for managing the project risks</li> </ul>	4
5	Study and use of software related to Project Management System.	3
6	Human Values and Professional Ethics Need, basic guidelines, content & process for value education, understanding harmony in the human being- harmony in myself, understanding harmony in the family & society- harmony in human relationship, understanding harmony in the nature & existence, implications of the above holistic understanding of harmony on professional ethics.	7
1	Text Books	
1	Dennis Lock ," Project Management ", Gower Publishing Limited, 2013 Samuel J. Mantel, Jr., Jack R. Meredith, Scott M. Shafer, Margaret M. Sutton, "Proj	ect
2	Management in Practice " JOHN WILEY & SONS, INC., 2011	
3	Horald Kerzner, "Project Management: A systems approach to planning, scheduling controlling", John Wiley & Sons Inc., 2009	and
1	References           K. Nagarajan, Project Management, New Age Int., 2nd ed. 2004.	
$\frac{1}{2}$	B.M.Naik, "Project Management-Scheduling and Monitoring", PERT/CPM, 1984	
3	William R Duncan, "A guide to the project management body of knowledge", PMI 1 1996	Publications,
4	The factories act 1948 – Government of India 6. Meri Williams , "The Principles of Management ", By – Site point Pvt Ltd., 2008	Project
-	Useful Links	
$\frac{1}{2}$	https://www.apm.org.uk/resources/what-is-project-management/	
2	https://www.projectmanager.com/project-management	

	CO-PO Mapping													
		Programme Outcomes (PO) PSO												
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	CO1 1 1 1													
CO2									2					2
CO3	CO3 1 2													
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													

		Assessment											
There are three components of lab assessment, LA1, LA2 and Lab ESE. IMP: Lab ESE is a separate head of passing.(min 40 %), LA1+LA2 should be min 40%													
Assessment Based on Conducted by Typical Schedule Marks													
	Lab activities,		During Week 1 to Week 8										
LA1	attendance,	Lab Course Faculty	Marks Submission at the end of	30									
	journal		Week 8										
	Lab activities,		During Week 9 to Week 16										
LA2	attendance,	Lab Course Faculty	Marks Submission at the end of	30									
	journal		Week 16										
	Lab activities,	Lab Course Faculty and	During Week 18 to Week 19										
Lab ESE	journal/	External Examiner as	Marks Submission at the end of	40									
	performance	applicable	Week 19										
Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing													
			ming, and other suitable activities, a										
· ·		course. The experimental	lab shall have typically 8-10 experin	nents and									
related activitie	es if any.												

		Walc	hand College	of Engineerin			
			1	2023-24	,		
				Information			
Progra	amme		B.Tech. (Electror	nics Engineering)			
	Semeste	r	Third Year B. Te	<u> </u>			
	e Code		6EN321	,			
	e Name		Electromagnetic	Engineering			
	d Requis	ites:	6	6 6			
	Teaching	g Scheme		Examination S	Scheme (Marks)		
Lectu		3 Hrs/week	MSE	ISE	ESE		Total
Tutori	-	# Hrs/week	30	20	50		100
140011					dits: #		100
			<u> </u>		(max) • 11		
			Course	Objectives			
1	Tound	erstand the electr	ric fields, electric e	•	1		
2			netic flux and force				
3		<u> </u>			electromagnetic wa	aves.	
					ke transmission lin		tennas and
4	wavegu					,	
			Outcomes (CO) w		nomy Level		
			ents will be able to				
CO1	Explair	the principles of	Static and time-var	rying electric and i	magnetic fields.		Understan d
CO2				c waves in free spa	ace and guided med	lium	Understan
~~~		-wire transmissio					d
CO3			atic and time-varying				Apply
CO4	Analyz	e the effects of ele	ectromagnetic radia	ation and electrom	agnetic interference	•	Analyze
Modu			Modulo	Contents			Hours
wiouu		ectrostatics	Module	Contents			nours
			alvsis and coordina	te systems. Coulo	mb's Law, electric		
I			•	•	ectric flux density,		4
-					energy and potent		
			ectric dipole; energ	U /			
			trics and Capacita				
II			density, continuity				8
		•	•		lielectric materials,		
		^	e's equations; Capa	acitance.			
		ady Magnetic Fi		I aw Ampere's	circuital Law, Stol	kes'	
					ar and vector magn		
III					en differential cur		8
					red in magnetic fi		
			materials, inductan				
	Tiı	ne Varying Field	Is and Maxwell's	Equations	·		
IV					ns in point (differen	tial)	8
	1		n, time varying pot		onic fields		
			ctromagnetic Way		a · · · · · ·		
.					flow in uniform pl		
V					nductors: skin de		7
		ne waves.	waves, standing	, wave railo, po	larization of unif	orm	
	pia	ne waves.					

	Transmission Lines	
VI	Types of two-conductor transmission lines, equivalent circuit, transmission line parameters, transmission line equations, lossless propagation, wave reflection, standing waves and voltage standing wave ratio, reflection coefficient, Smith Chart.	4
	Textbooks	
1	William H. Hayt and John A. Buck, "Engineering Electromagnetics", 7 th Edition, McGraw-Hill, 2007.	
2	Matthew N. O. Sadiku, "Elements of Electromagnetics", 3 rd Edition, Oxford Un Press, 2007.	niversity
3	S. C. Mahapatra and Sudipta Mahapatra, "Principles of Electromagnetics", Tata Hill, 2011.	McGraw-
4		
	References	
1	E. C. Jordan & K. Balman, "Electromagnetic Waves and Radiating Systems", 2 nd PHI, 2007.	Edition,
2	David K. Cheng, "Field and Wave Electromagnetics", Pearson Education, 2015.	
3		
4		
	Useful Links	
1	https://nptel.ac.in/courses/108/106/108106073/	
2	https://nptel.ac.in/courses/108/104/108104087/	
3		
4		

	CO-PO Mapping														
		Programme Outcomes (PO) PSO													
	1	1 2 3 4 5 6 7 8 9 10 11 12 1 2													
CO1		2											2		
CO2		2		1									2		
CO3	3												2		
CO4	CO4 3 2 2 2														
The stren	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High														
Fach CO	of the c	ourse i	must m	an to at	least o	ne PO									

Each CO of the course must map to at least one PO.

Assessment

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		Walc		of Engineering, Statutonomous Institute)	Sangli		
			AY	2023-24			
			Course I	Information			
Progra	amme		B.Tech. (Electron	nics Engineering)			
Class,	Semester		Third Year B. Te	ch., Sem VI			
Cours	e Code		6EN322				
Cours	e Name		Digital System A	rchitecture			
Desire	d Requisit	tes:	Digital Electronic	es			
I	Teaching	Scheme		Examination Sch	eme (Marks)		
Lectur	re	3 Hrs/week	MSE	ISE	ESE		Total
Tutori	al	-	30	20	50		100
				Credits	: 3		
			Course	Objectives			
1	To expl	ain the designs	of building block	ks of digital system	viz. data path	design, co	ontrol
1	unit desi	gn, memory ur	nits to finally desi	gn the microprocess	sor 2. 3. 4. 5.		
2				ng the robust digital			
3				l ADCs using variou	is approaches	motivatir	ng
			eir performance.				
4			plexity digital sy	stem design related	problems in ba	atches as	a self
-	study ex						
	To illust	rate HDL 1mpl	ementation of dig	gital designs in FPG.	A		
		Course	Dutaamaa (CO) w	:th Dloom's Toyonov	my Loval		
At the	end of the		ents will be able to	ith Bloom's Taxonor	lly Level		
CO1				, the concept behind			
	-	mable devices				Underst	tand
CO2	1 0		o develop sequen	tial digital circuits, a	and floating	. 1	
				op architectures of f		Apply	
	pointdata	a-path blocks.			C		
CO3	Analyze	digital circuits	and their archite	ctures for functional	ity, and	Analyz	e
			• •	sing timing diagrams			
CO4	1	11	U	ng memory blocks, I		Evaluat	e
				d demerits and perfo	rmance		-
005		ers respectively			• • .1		
CO5				Data-path, Control u	inits) with	Create	
			fined set of instru	rther to 4-bit/8-bit			
	meropre						
Modu	le		Modu	le Contents			Hours
Mouu		ning Datapat		it contents			Hours
				nd floating point), F	ixed Pont arit	hmetic	
Ι				adders/ Multipliers		innetie,	8
				peline processing.			
		ning Control		<u></u>			
		, 0		ples on hardwired co	ontrol (Multipl	ier	
II		1 .		oprogrammed Conti	· 1		6
				unit, Concepts in Pi		T	

Ш	Designing Memory BlocksROM, Internal Structure, Rom control inputs and timing, Static RAM, InternalStructure, Timing, Dynamic RAM, Timing, Memory Systems (Multilevelmemories, Address translation, replacement policies), Caches (Addressmapping, Associative, Direct and set-associative mapping), Cacheperformance	7
IV	Processor DesignIntroduction, Microcomputer Organization, Microprocessor Organization, Setof Instructions, Addressing Modes, Designing instruction, stack, subroutinesand interrupt, Input-Output interface, Serial and parallel communication withprocessor, Direct Memory Access	6
V	PLDs and Their ArchitecturesIntroduction to Programmable Logic Devices, Field Programmable GateArrays, FPGA Architectures (Xilinx Spartan Series, Altera Stratix Series)involving Configurable Logic Blocks, I/O blocks, Programmableinterconnects.	4
VI	Data Converters: DACBinary weighted Resistor , R/2R ladder, Performance metrics of DAC(Resolution, Settling time, linearity, speed and Errors) ADC – Flash ADC,Successive Approximation ADC, Single slope ADC, Dual Slop ADC, ADCspecifications (Quantization error, Intergral non-linearity error, Gain andOffset Error, Signal to Noise Ratio, Dynamic Range, Effective number of bits,Bit Error Rate, Figure of Merit)	9
	Textbooks	
1	Morris Mano, "Digital Logic and Microprocessoor Design", PHI, 2001	
2	John Wakerley, "Digital Design, Principles and Practices", PHI, 2005 3.	
3	Hayes, "Computer Architecture and Organization", McGraw Hill, 3rd Edition, 20	012
	D.f	
1	References	
	Frank Vahid "Digital Electronics" Wiley Publication. 2012Enoch O. Hwang, "Digital Logic and Microprocessoor Design with VHDL", The	omeon
2	Publication, 2007 Reprint	101115011
	Useful Links	
1	www.xilinx.com	
2	www.altera.com	

						CO-PC) Mapp	oing							
		Programme Outcomes (PO)													
	1	1 2 3 4 5 6 7 8 9 10 11 12 1 2													
CO1	CO1 2 2														
CO2	CO2 3														
CO3		3													
CO4		3													
CO5			3			1	1							3	
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High														
Each CO	Each CO of the course must map to at least one PO.														

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		W		ge of Engineerin							
			· · · · · · · · · · · · · · · · · · ·	Y 2023-24							
			Cour	se Information							
Progra	amme		B. Tech. (Electror	nics Engineering)							
Class,		ster	Third Year B. Tec	<u> </u>							
Cours			6EN323								
Cours	e Nam	e	Power Electronics	5							
Desire	d Req	uisites:	Basic Electrical E	ngineering, Circuit T	heory						
				<u> </u>	5						
Te	eachin	g Scheme		Examination So	cheme (Marks)						
Lectur	re	3 Hrs/week	MSE	ISE	ESE	Total					
Tutori	ial	-	30	20	50	100					
Practi	cal	-		1	1						
Intera	ction	-		Cred	its: 3						
			Cou	rse Objectives							
1	Expl	ain the working		•	es and their application	ns.					
	Expl	ain the working	g of power conver	ter circuits like cont	rolled rectifier, inve	rter, AC voltage					
2				knowledge of perform	mance parameters of	converters in the					
		sis of their perf		. 1 . 1 . 1.1							
3				DC motors and Induc	e converters, choppe	rs, inverters and					
					t and a power semic	onductor device					
4			lectrical power cont		t und a power senne						
	1	<u> </u>	*) with Bloom's Tax	onomy Level						
At the		,	students will be abl	· · ·							
CO1				nductor devices such	n as SCR, GTO, Pov	ver Understand					
		FET and IGBT		DC to D	C	A					
CO2		o AC converter.		rectifiers, DC to D	C converters, Inverte	rs, Analyze					
				of controlled rectifie	r, DC to DC convert	er, Evaluate					
CO3			and AC to AC conv		,	,					
CO4	Anal	yze the speed co	ontrol techniques/ n	nethods for AC and I	DC motors.	Analyze					
Modu				ule Contents		Hours					
		ower Semicond									
Ι					del, protection circu mutation circuits; GT						
				BJT, Power MOSF		0,					
		hase Controlle	,		,						
	S	ingle phase halt	f and full wave con		R and RL load, Sing	gle					
) and fully controlled							
II					e load, three phase h						
					nd RL load; Calculation rters: Fourier analys						
		•		erformance of control	•	15,					
			C voltage Controll								
	S	ingle phase ha	lf and full bridge	inverter using trai							
	p	erformance par	ameters, Fourier a	malysis of inverter	output voltage; Th	ree					
III	III Single phase half and full bridge inverter using transistor/MOSFET/IC performance parameters, Fourier analysis of inverter output voltage; T phase bridge inverter-120 ⁰ and 180 ⁰ conduction mode; PWM inverters; S and Parallel resonant inverter.										
				and three phase ΛC	voltage controllers, A	NC 8					
	_ _	power control using TRIAC; Cycloconverters: single phase to single phase three phase to single phase, three phase to three phase cycloconverter.									
		C to DC conve	<u> </u>	1 - 7							
IV					C, current limit contr	ol; 4					
		mes of chonner	sten un chonner m	ultiphase chopper; S	MPS.						

Course Contents for B. Tech. Programme, Department of Electronics Engineering, AY2023-24

V	D.C. Motor Control Equivalent circuit, speed torque characteristics (separately excited and series motor), operating modes, single phase and three phase controlled rectifier fed drives; four quadrant drive-single phase and three phase dual converter; Chopper-fed DC drive.	6
VI	A.C. Motor Control Equivalent circuit, speed torque characteristics, speed control methods-stator voltage control, rotor voltage control, frequency control, stator voltage and frequency control (V/F); Vector Control.	6
	Text Books	
1	M. D. Singh & K. B. Khanchandani, " <i>Power Electronics</i> ", Second Edition, Tata M Publishing Company Ltd., New Delhi, 2007.	AcGraw-Hill
2	M.H. Rashid, "Power Electronics: Circuits, Devices & Applications", Third Edition Delhi, 2008.	n, PHI, New
3	P. S. Bimbhra, "Power Electronics", Third Edition, Khanna Publishers, 2004.	
4		
	References	
1	P. C. Sen, "Power Electronics", First Edition, Tata McGraw Hill Publishing Company	/ Ltd, 2008.
2	V. R. Moorthi, "Power Electronics-Devices, Circuits and Industrial Applicatio University Press, 2010.	ns", Oxford
3	Ned Mohan, T. M. Undeland, W. P. Robbins, "Power electronics-Converters, Apple Design", Third Edition, John Wiley and Sons Inc., 2003.	lications and
4		
	Useful Links	
1	https://nptel.ac.in/courses/108/105/108105066/#	
2	https://nptel.ac.in/courses/108/108/108108077/	
3	https://nptel.ac.in/courses/108/102/108102145/	
4		

CO-PO Mapping														
	Programme Outcomes (PO)												5 0	
1	2	3	4	5	6	7	8	9	10	11	12	1	2	
2														
2	3	1											2	
2	3													
	2	2											2	
	2	2 3	$\begin{array}{c c} 2 \\ \hline 2 \\ \hline 3 \\ \hline 1 \\ \hline \end{array}$	1 2 3 4 2	1 2 3 4 5 2 2 3 1	Programme C 1 2 3 4 5 6 2 2 2 2 2 2 2	Programme Outcom 1 2 3 4 5 6 7 2 2 3 1 2 1	Programme Outcomes (PC 1 2 3 4 5 6 7 8 2 2 2 2 1 2 1 2 1	Programme Outcomes (PO) 1 2 3 4 5 6 7 8 9 2 2 - - - - - - 2 3 1 - - - - - -	Programme Outcomes (PO) 1 2 3 4 5 6 7 8 9 10 2	1 2 3 4 5 6 7 8 9 10 11 2 2 2	Programme Outcomes (PO) 1 2 3 4 5 6 7 8 9 10 11 12 2 2 3 1	I 2 3 4 5 6 7 8 9 10 11 12 1 2	

The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High Each CO of the course must map to at least one PO.

Assessment

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Wale		of Engineerin ed Autonomous Insti					
			AY	2022-23					
			Course	Information					
Progra	amme		B.Tech. (Electron	nics Engineering)					
Class,	Semester		Third Year B. Te	ch., Sem -VI					
Cours	e Code		6EN371						
Cours	e Name		Digital System A	rchitecture Lab					
Desire	d Requisi	tes:	Digital Electronic	es Lab					
r	Feaching	Scheme		Examination	Scheme (Marks)				
Practi	cal	2 Hrs/ Week	LA1	LA2	Lab ESE	Total			
Intera	ction		30	30	40	100			
				Cre	dits: 2				
			Cours	e Objectives					
1	To knov	v the HDL lan	guage for Digital	Design					
2				nd other high lev	el programming	language			
3	To unde		cept in simulation						
				with Bloom's Tax	onomy Level				
	1	,	lents will be able t						
001	The students will be able to design the basic digital circuits and test them. Understand								
CO1 CO2	Able to develop designed circuit using VHDL Apply								

Able to implement the control unit using VHDL

List of Experiments / Lab Activities/Topics

Analyse

VERILOG: Introduction to VERILOG, Program structure, Attributes, Functions and Procedures, Types of VERILOG architectures(Structural, Data flow, Behavioral), VERILOG concurrent and sequential constructs, Combinational and Sequential logic design using Verilog

List of Lab Activities:

CO3

- 1 Introduction to Xilinx with sample experiment in Verilog
- 2 1 bit full adder using 1 bit half adder as a component
- 3 4 bit full adder using 1 bit full adder as a component.
- 4 1 bit full adder using 8:1 multiplexer as component
- 5 1 bit full adder using 1:8 demux as component
- 6 Implementation of 4:1 mux using 2:1 mux as a component
- 7 Implementation of demultiplexer IC 74138
- 8 4 bit comparator
- 9 Implementation of flip flops
- 10 4-bit Counter using D-f/f
- 11 Counter using operators
- 12 UP counter and DOWN counter
- 13 Shift registers
- 14 Universal Shift register

	Textbooks						
1	Douglas Perry, "VERILOG", , Tata McGraw-Hill,						
2	Charles H Roth, "Digital System Design Using VHDL", Cengage Learning India						
	References						
1	Steafan, "Fundamentals of Digital Logic Using VERILOG ", McGraw Hill						
2	Manjita Srivastava ,"Digital Design: HDL-Based Approach",,Cengage Learning India						

Course Contents for BTech Programme, Department of Electronics Engineering, AY2023-24

	Useful Links						
1	www.xilinx.com						
2	www.altra.com						

	CO-PO Mapping													
]	Progra	mme C	outcom	es (PO)				PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													
CO2		3												
CO3						1	1							2
The strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High														
Each CO	O of the	e course	e must i	nap to	at least	one PC), and p	referab	ly to or	nly one	PO.			

	1		LA2 and Lab ESE. %), LA1+LA2 should be min 40%					
Assessment	Based on	Conducted by	Typical Schedule	Marks				
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30				
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30				
Journal Lab Course During Week 18 to Week 19 Lab activities, Faculty and Marks Submission at the end of Week 19 Lab ESE journal/ External performance Examiner as applicable Image: Construction of the second secon								

related activities if any.

			Α	Y 2023-24			
				se Information			
Progra	amme		B. Tech. (Electron				
Class,		ster	Third Year B. Te	<u> </u>			
Cours			6EN372				
Cours			Power Electronic	s Lab			
		uisites:		Engineering, Circuit	Theory		
Desire	u neq		Dusie Lieetrieur L	ingineering, eneur	Theory		
Т	eachin	g Scheme		Examination	Scheme (Marks)		
Practi		2 Hrs/Week	LA1	LA2	Lab ESE		Total
Intera		2 1115/ W CCK	30	30	40		100
mera	cuon		30		dits: 1		100
				Cre			
1	F 1	1. 4. TT 1		rse Objectives	1.1.1	•.	.1.
1					vices and their use as safety measures) of		
2	1	rimental set ups.	U	ng procedure (i.e.	safety measures) of	1 powe	r electroni
				cuit ground and cor	ntrol circuit ground (use of	Powerscon
3					s and measurement of		
					, inverter and choppe		1
4					ATLAB, PSPICE) ir		nalysis an
4	desig		tronic circuits /syste				
) with Bloom's Ta	axonomy Level		
			students will be abl				TT 1
<u>CO1</u>	<u> </u>	^		<u> </u>	V-I characteristics.		Understan
CO2					s, inverters, chopper		Apply
CO3	chop	•	ance power electro	onic circuits (contr	olled rectifiers, inver	rters,	Analyze
CO4			e speed control tec	hniques/ methods f	or AC and DC motor	'S.	Analyze
001	Entan					5.	
			List of Experime	ents / Lab Activitie	s/ Topics		
The pr	imarv	objective of this			knowledge of power	· electro	onic circuit
					course develops a ba		
					y experimentation an		
			num 8 experimen				
1.		-		SCR, Power MOS	FET, IGBT.		
2.			its: R, RC, and UJ7				
3.	-	-	ntrolled bridge recti				
4.	-		ntrolled bridge rect	tifier.			
5.	•	e phase transist					
6.	-	· ·	e phase Cycloconv				
7.				A chopper (Power M	OSFET based) circu	iit.	
8.		ower control us		(1DC 1)			
9. 10		e/ Three phase oper fed DC driv	controlled rectifier	ted DC drive.			
	-	e phase inductio					
		-	ive (Dual converter	r)			
		•		<i>. j.</i>			
			shless DC motor.		o: : :		
	Sim	lation of Contro	lled Rectifier and 7	Chree Phace Invorta	r ('ircilit licing MIAT		

Delhi, 2008.		*	

M.H. Rashid, "Power Electronics: Circuits, Devices & Applications", Third Edition, PHI, New

1

2	M. D. Singh & K. B. Khanchandani, " <i>Power Electronics</i> ", Second Edition, Tata McGraw-Hill Publishing Company Ltd., New Delhi, 2007.
3	V. R. Moorthi, "Power Electronics: Devices, Circuits and Industrial Applications", Oxford University Press, 2010.
4	
	References
1	D. R. Grafham, J. C. Hey, "SCR Manual", Fifth Edition, General Electric, New York, 1972.
2	https://www.powersimtech.com/wp-content/uploads/2021/01/PSIM-User-Manual.pdf
3	
4	
	Useful Links
1	https://powersimtech.com/products/psim/capabilities-applications/
2	https://in.mathworks.com/solutions/power-electronics-control/power-electronics-simulation.html
3	https://www.plexim.com/products/plecs
4	

	CO-PO Mapping													
				Р	rograi	nme C) utcon	nes (PC))				PSO	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	1			3										
CO2				3	3									2
CO3		1		3	3									2
CO4	1			3	2									
The strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High														
Each CO	of the	course	must r	nap to	at leas	t one P	O. and	prefer	ably to	o only o	one PC).		

	Assessment							
	ee components of lab a E is a separate head of		LA2 and Lab ESE. %), LA1+LA2 should be min 40%.					
Assessment Based on Conducted by Typical Schedule Marks								
LA1	Lab activities,	Lab Course	During Week 1 to Week 6	30				
LAI	attendance, journal	Faculty	Marks Submission at the end of Week 6	50				
LA2	Lab activities,	Lab Course	During Week 7 to Week 12	30				
LAZ	attendance, journal	Faculty	Marks Submission at the end of Week 12	50				
Lab ESE	Lab activities,	Lab Course	During Week 15 to Week 18	40				
Lab ESELab counce, journalLab counceDating week 1640Attendance, journalFacultyMarks Submission at the end of Week 18								
Week 1 indica	ates starting week of a	semester. Lab act	tivities/Lab performance shall include perform	ming				

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

		Wale		ed Autonomous Ins					
	AY 2023-24								
				Information					
Progra			B. Tech. (Electro	<u> </u>	g)				
	Class, Semester Third Year B. Tech., Sem-VI								
Cours	Course Code 6EN342								
Cours	Course Name Mini Project-2								
Desire	Desired Requisites: ECAD-I, ECAD-II, Digital Signal Processing, Embedded System Design,								
			Digital Signal Pr	ocessing					
r	Teaching	Scheme		Examination	n Scheme (Marks)				
Practi	cal	2 Hrs/ Week	LA1	LA2	Lab ESE	Total			
Intera	ction	-	30	30	40	100			
				С	redits: 1				
		1	1						
			Cours	e Objectives					
	To provi	de students han	ds on experience o	on, troubleshootir	ng, maintenance, fabric	ation, innovation,			
1	record ke	eeping, docume			skill and competency pa				
	education								
2	l		environment and cu			1 2			
3			thinking and pract	ice based learnin	g and thereby preparin	g students for			
		al year project.	ann an 11 sy ithin dan	anter anta ta anav	no ontimol usopo of inf	un atma atma			
4	Facilities		ice cell within dep	artiments to ensu	re optimal usage of infi	rastructure			
	Taemnes		Outcomes (CO)	with Bloom's Te	axonomy Level				
At the	end of the		dents will be able t						
C01			nage a minor proje			Understand			
					distinct manner thro				
CO2			nd design techniqu						
CO3			ng hardware and/o			Create			
CO4	Execute	the project and	comment upon the	e results of it.		Analyze			
		L	ist of Experiment	ts / Lab Activitie	es/ Topics				
A proj constru concei related after a Each s throug at the o	ect group uction, and ve, design d to electr in exhaus student mu hout the s end of the	d debugging of and develop th conics engineer tive survey. ast keep a proje emester, as part	f an electronic system the idea leading to ing discipline to l exect notebook/logbo t of in-semester-ev	stem approved b a project/produc be decided by th bok. The project valuation. The stu	he mini project will in y the department. Eac t. The theme of the p te students based on the notebooks will be che udent should submit a oject should be demons	cked periodically soft bound report			
of exai	mination.		Te	extbooks					
1	Elect	ronics Projects			nd Nancy Muir, Publis	shed by Wiley			
1	Publi	ishing, Inc., 200	6		•				
2	Make	e: Electronics, b	y Charles Platt, Pu	blished by Make	er Media, 2015				
3									
4									
				eferences					
1	A. E. 1996		Angus, "Electronic	Product Design'	', Stanley Thrones (Pul	blishers) Limited,			
	Paul Horowitz, Winfield Hill, "The Art of Electronics", Cambridge University Press, 1989								

Course Contents for BTech Programme, Department of Electronics Engineering, AY2023-24

3						
4						
	Useful Links					
1						
2						
3						
4						

	CO-PO Mapping													
	Programme Outcomes (PO)										PS	50		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3	3								2	2			2
CO2			3		2									
CO3			3		2						1		1	1
CO4		2							3	3				
The stre	The strength of mapping is to be written as 1,2,3; where, 1: Low, 2: Medium, 3: High													
Each CO	Each CO of the course must map to at least one PO, and preferably to only one PO.													

A	Assessment

There are three components of lab assessment, LA1, LA2 and Lab ESE. IMP: Lab ESE is a separate head of passing.(min 40 %), LA1+LA2 should be min 40%

Assessment	Based on	Conducted by	Typical Schedule	Marks
LA1	Lab activities, attendance, journal	Lab Course Faculty	During Week 1 to Week 8 Marks Submission at the end of Week 8	30
LA2	Lab activities, attendance, journal	Lab Course Faculty	During Week 9 to Week 16 Marks Submission at the end of Week 16	30
Lab ESE	Lab activities, journal/ performance	Lab Course Faculty and External Examiner as applicable	During Week 18 to Week 19 Marks Submission at the end of Week 19	40

Week 1 indicates starting week of a semester. Lab activities/Lab performance shall include performing experiments, mini-project, presentations, drawings, programming, and other suitable activities, as per the nature and requirement of the lab course. The experimental lab shall have typically 8-10 experiments and related activities if any.

		Walc	hand College (Government Aided	of Engineerin d Autonomous Instit			
				2023-24			
				Information			
Progra	mme		B.Tech. (Electron	nics Engineering)			
0	Semester		Third Year B. Te	ech., Sem VI			
Course Code 6EN331							
Course Name Mobile Communication Engineering							
Desired	l Requisit	tes:	Probability Theo	ry and statistics, D	igital Communication E	ngineering	
ſ	Feaching	Scheme		Examination	Scheme (Marks)		
Lectur	e	3 Hrs/week	MSE	ISE	ESE	Total	
Tutoria	al	-	30	20	50	100	
				Cre	dits: #		
			1				
			Course	Objectives			
1		uce the concept	s and techniques a	ssociated with Win	eless Cellular Commun	ication	
	systems	aniza with state	of art standards us	ad in winalaga aall	ular avatarea		
2	10 famili		Outcomes (CO) w				
At the e	end of the		lents will be able to				
CO1		y fundamentals of cellular system design to improve performance of					
	cellular n		2			Apply	
CO2			erent multiple acce			Analyze	
CO3	Study evo	olution of mobil	le communication	generation standar	ds	Analyze	
Modul	e		Module	e Contents		Hours	
Ι	Large Electi Refle	Mobile Radio PropagationLarge Scale Path Loss - Free Space Propagation Model, Relating Power toElectric Field, Three Basic Propagation Mechanisms -Reflection (GroundReflection), Wave Propagation and its types: Ground wave, space wave and skywave propagation, Diffraction, Scattering, Practical Link Budget, Fading and					
II	Basic Basic Effici Fields Theor	s of Antenna Antenna Para ency, Directivi from Oscillat rems, Radiation	ity-Gain-Resolution ting Dipole, Field , Retarded Potentia	n, Antenna Aper l Zones, Front - als – Helmholtz Th	diation Intensity, Bean tures, Effective Height to-back Ratio, Antenna eorem	. 6	
III The Cellular Conce Introduction of Ce Capacity: Erlang Pe ratio, Co channel int		pt – System Design Fundamentals Ils, Channel Reuse, SIR Calculations, Traffic Handling rformance, Cellular system design, Cochannel interference erference reduction techniques and methods to improve cell / management and channel assignment, concepts of cell					
IV	Multiple Access Technologies Frequency Division Multiple access (FDMA), Time Division Multiple access (TDMA) Code Division Multiple access (CDMA)					$\frac{y}{s}$ 4	
V	Fund GSM netwo GSM	amentals of GS standard. The ork. Air interfa	basic architecture ce in GSM, logica ns TRAU, BSC, B	al and physical cl	rk, Interfaces in a GSM hannels. Radio Networl entral network function	x 8	

Course Contents for BTech Programme, Department of Electronics Engineering, AY2023-24

VI	5G TechnologyHSPA and LTE – Architecture – Radio interface and channels – Resourcemapping – Session, mobility and security procedures – LTE Advanced –Heterogeneous Networks – Internetworking, IP based coupling Architecture -Multimode terminals and intersystem handover
	Textbooks
1	T.S.Rappaport, "Wireless Communications Principles and Practice", II Ed. PHI, Publications 2010
2	Prashant Kumar Patra, Sanjit Kumar Dash, "Mobile Computing", 2nd Edition, Scitech, 2014
3	V.K.Garg, J.E.Wilkes, "Principle and Application of GSM" Pearson Education, 1999
4	
	References
1	William C. Y. Lee, " <i>Mobile Communication Engineering: Theory and Applications</i> ",2nd Edition, McGraw Hill Publication, 1997
2	Iti Saha Misra, "Wireless Communication and Networks – 3G and Beyond", Mc Graw Hill Education, Second Edition, 2013
3	Mischa Schwartz, " <i>Mobile Wireless Communication</i> ", 1st Edition, Cambridge University Press, 2009.
4	Antenna Theory - C.A. Balanis, John Wiley & Sons, 3rd Ed., 2005.
	Useful Links
1	
2	
3	
4	

CO-PO Mapping														
		Programme Outcomes (PO)										PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1		3												
CO2			3										3	
CO3		3												
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High														
Each CO	Each CO of the course must map to at least one PO.													

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Walc	hand College ((Government Aided	of Engineering Autonomous Institut				
			AY2	2023-24	,			
			Course I	nformation				
Progra	amme		B.Tech. (Electron	ics Engineering)				
	Semester		Final Year B. Tec	h., Sem VII				
Course Code 6EN332								
Course	e Name		Digtal System En	gineering				
Desire	d Requisit	tes:						
	Teaching			Examination S				
Lectur						To		
Tutori	al	0 Hrs/week	30	20	50	10	00	
				Cred	its: 3			
				Objectives				
1					power, noise,	signali	ng	
			ted with high s	· · · ·	,	• .•	<i>,</i> 1	
					connects in res			
2	-	-			lesign the appr		s t0	
					gineering mode			
3		-			ence (noise) in		be and	
3	systems and apply engineering/statistical models of these to compute and compare bit error rates							
	<u> </u>			onaling & timi	ng issues and	annly t	he	
4					ansfer of inform			
-		ne location t				1411011	(8100)	
I		Course	Outcomes (CO) w	ith Bloom's Taxor	nomy Level			
			ents will be able to					
CO1	Unders	tand Interco	onnects as des	ign objects, No	oise in digital			
	system	s and its im	pact to system	operation			II	
COA								
CO2	•	-	a synchronizat	ion for functio	nal operations		IX 7	
	and si	gnalling					IV	
CO3	Diation	nich Domon	distribution so	homes for low	noise			
005	Distillig	uisii ruwel	uisti ibution se	11011108 101 10W	110196		IV	
CO4	Explair	n Signal and	signalling cor	ventions for o	n-chip and off-			
	-	mmunicatio			I		II	
	p 00							
Modu	le		Module	Contents			Hours	
	Wire	s: Geometry	y and Electrica	l properties, E	lectrical model	.s		
	of wi	ires (Ideal w	ire, Transmiss	ion line), Simp	le transmissio	n		
	lines (RC, lossless LC, lossy LRC transmission lines,							
т	Dielectric obcorntion) Special transmission lines (Multi dran						7	
Ι		_	. –		on and differen	-	7	
			e, Isolated line					
	Inou	c impluance	, isolated mile	S)				

II	Noise in Digital System: Noise sources in a digital system, Power Supply Noise, Cross-talk, Inter-symbol Interference, Noise due to other sources (Alpha particles, Electro-magnetic	7
	Interference, Process variation, Thermal Noise, Shot Noise, Flicker or 1/f Noise), Managing noise.	,
III	Signaling Conventions: CMOS and Low swing current mode signaling system, Considerations in transmission system design, Signaling modes for transmission lines, Transmitter signaling methods, Receiver signal detection, Source termination, Under-terminated Drivers, Differential Signaling, Signaling over capacitive transmission medium, Signal encoding	7
IV	Timing Convention: Conventional Synchronous system and closed loop pipelined system, considerations in timing design, Timing fundamentals, Timing properties of combinational logic and clock storage elements, Eye diagram, Encoding Timing (Signals and Events), Open loop synchronous timing, Closed loop timing, Phase locked loops, Clock Distribution	6
V	Synchronization: Synchronization Fundamentals, Applications of synchronization (Arbitration of asynchronous signals, Sampling asynchronous signals, Crossing clock domains), Synchronization failure and meta-stability, Synchronizer Design (Mesochronous, Plesiochronous, Periodic Asynchronous)	6
VI	Power Distribution: The power supply network (Local loads, Signal loads), Local Regulation, Logic loads and on-chip power supply distribution (Logic current profile, IR drops, Area Bonding, On-chip by-pass capacitor), Power supply isolation (Supply-supply isolation, Signal-supply isolation), Bypass capacitors, Power Distribution system	6
	Textbooks Digital System Engineering, William Dally and John Poulton,	
1	Cambridge University Press, Reprint 2007	
2		
3		
4		

	References							
1	High Speed Digital Design, A Handbook of Black Magic, Howard W. Johnson, Martin Graham, Prentice Hall PTR, Englewood Cliffs, NJ 0763.							
2	High Speed Digital System Design: Interconnect Theory and Design Practices" Stephen H. Hall, Garrett W. Hall, James A. McCall, Wiley- IEEE Press (ISBN: 978-0-471-36090-2							
3								
4								
	Useful Links							
1	http://cva.stanford.edu/books/dig_sys_engr/							
2								
3								
4								

CO-PO Mapping														
		Programme Outcomes (PO)									PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3													
CO2	3													
CO3				3										
CO4				3										
The strength of mapping is to be written as 1: Low, 2: Medium, 3: High														
Each CO of the course must map to at least one PO.														

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

	AY 2	2023-24							
	Course I	nformation							
me	B.Tech. (Electron	ics Engineering)							
Class, Semester Third Year B. Tech., Sem VI									
ode	6EN333								
Course Name Professional Elective 3- Design and Analysis of Algorithm									
Requisites:	Data Structure and	d Algorithms							
Teaching Scheme Examination Scheme (Marks)									
3 Hrs/week	MSE	ISE	ESE	Total					
-	30	20	50	100					
		Cred	its: 3						
I									
	Course	Objectives							
explain Comparative omplexities,	features of algor	rithms on the bas	sis of space, time	omputational					
	explain the selection criteria for identifying, formulating and applying a typical algorithm for								
Course (Outcomes (CO) w	ith Bloom's Taxor	nomy Level						
· · · · · · · · · · · · · · · · · · ·		,		Apply					
		the basis of spar	ce, time	Analyze					
		oblem.		Analyze					
• • •	<u> </u>								
	Module	Contents		Hours					
Introduction									
-			•						
pointers, linked stacks and queues, trees and recursion, Hashing:- Sparse-table,									
hash function, collision resolution with open addressing and collision resolution									
	0 0								
-	•			8					
· • ·	-		ver bound, &						
_		gorithm							
		atuix maritimlianti	algorithm Timiter	n					
of divide and conq	.		•	X					
	ning & Greedy A	oproach							
•	· ·		path. Chain matri	x					
			-						
	-								
	ode Ime equisites: Ime equisites: Image: Scheme a Hrs/week - a Hrs/week - a Hrs/week - a Hrs/week - a Provide different algor - a provide and complexi - a provide and dynamic s - b provide and dynamic s - b provide and conque -	ode 6EN333 ame Professional Elec equisites: Data Structure an ching Scheme Data Structure an ching Scheme 3 Hrs/week 3 Hrs/week MSE - 30 provide different algorithm approaches In explain Comparative features of algorithmic explain Comparative features of algorithmic explain the selection criteria for identify and the course, the students will be able to the problem. Course Outcomes (CO) w of the course, the students will be able to the course, the students will be able to the protein algorithm approaches I excursive techniques. compare the different algorithms on to omputational complexities entify the optimum algorithm for given presentify the optimum algorithm for given present (theap sort), Shell sort. C	de 6EN333 ame Professional Elective 3- Design and Quisites: Data Structure and Algorithms ching Scheme Examination Scheme 3 Hrs/week MSE ISE - 30 20 - 30 20 provide different algorithm approaches like static, dynamic, explain Comparative features of algorithms on the bas mplexities, - • explain the selection criteria for identifying, formulating an een problem. - Course Outcomes (CO) with Bloom's Taxor of the course, the students will be able to, neterpret different algorithm approaches like static, dynamic cursive techniques. ompare the different algorithms on the basis of space omputational complexities entify the optimum algorithm for given problem. Module Contents Introduction Static and dynamic structures, stacks, queues, dynamic n pointers, linked stacks and queues, trees and recursion, H hash function, collision resolution with open addressing at by chaining Sequential search, Binary search, Comparison of trees, Ins sort(Heap sort), Shell sort. Computational Complexity, low comparison of searching and sorting algorithm Divide and Conquer Merge sort, quick sort (portioning), Matrix multiplication of divide and conquer. Computational complexity of algorithms. Dynamic Programming & Greedy Approach Bin	ode 6EN333 ame Professional Elective 3- Design and Analysis of Algorithm equisites: Data Structure and Algorithms ching Scheme Examination Scheme (Marks) 3 Hrs/week MSE ISE - 30 20 50 Credits: 3 Provide different algorithm approaches like static, dynamic, iterative and recursive explain Comparative features of algorithms on the basis of space, time of the course, the students will be able to, anterpret different algorithm approaches like static, dynamic, iterative and recursive explain the selection criteria for identifying, formulating and applying a typical zen problem. Course Outcomes (CO) with Bloom's Taxonomy Level of the course, the students will be able to, anterpret different algorithm approaches like static, dynamic, iterative and ccursive techniques. iompare the different algorithm of given problem. Module Contents Introduction Static and dynamic structures, stacks, queues, dynamic memory allocation and pointers, linked stacks and queues, trees and recursion, Hashing:- Sparse-table hash function, collision resolution with open addressing and collision resolution by chaining Sequential search, Binary search, Comparison of trees, Insertion sort, Selection sort, Selection sort, Selection sort, Selection sort, Selection sort, Gelexion and pointers, Shell sort. Computational Complexity, lower bound, & comparison of searching and sorting algorithm Divide and Conquer Merge sort, quick sort (portioning), M					

V	Back Tracking & Branch and Bound Back tracking techniques, the n-queens problem, Back tracking algorithm's efficiency using Monte Carlo algorithm. Graph coloring, the Hamiltonnian circuits' problem. Backtracking Algorithm for 0-1 Knapsack problem and its comparison	7					
VI	Theory of NP The three general categories of problems. The sets P & NP. NP complete problems, NP-Hard, NP-easy, NP – Equivalent problems, NP Hard problems	4					
	Textbooks						
1	Ellis Horowitz, Sartaj Sahani, Sangutherar "Fundamentals of Computer Algorithms", Rajasekaran., Galgotia Pubication Ltd, 2010						
2	I. Chandra Mohan, "Design and Analysis of Algorithms", PHI Publication, 2012.						
3	Horowitz and Sahni, "Analysis of Computer Algorithms", Galgotia Publishers., 2007						
4							
	References						
1	Richard E. Neapolita & Kumarss Naimipour, "Foundation of Algorithms", (North Illinois University), D.C. Heath and Company, Publication, 1996.	neastern					
2	Robert L. Kruse & Brunce P. Leung et. Al, "Data Structures and Program Desig Publication, 1984.	gn" <i>C</i> PHI					
3							
4							
	Useful Links						
1							
2							
3							
4							

	CO-PO Mapping													
		Programme Outcomes (PO) PSO										50		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1		1												
CO2	2													2
CO3			2											
CO4		1												
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	Each CO of the course must map to at least one PO.													

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

		Wald	hand College ((Government Aided	of Engineering						
				2023-24	,					
			Course I	nformation						
Progr	amr	ne	B.Tech. (Electron	nics Engineering)						
Class,			Third Year B. Te							
Cours			6EN334	,						
Cours				Network Protocols						
		equisites:		cation, Data Comm	unication					
DUSIT	u N	equisites.	Digital Commun	Cation, Data Comm	lumeation					
	Tea	ching Scheme	Examination Scheme (Marks)							
Lectu	re	2 Hrs/week	MSE	ISE	ESE	Total				
Tutor	ial	1 Hrs/week	30	20	50	100				
				Cred	its: 3					
		1	1							
			Course	Objectives						
1		develop an understar		etworking basics						
2		be exposed to the TC								
3		develop an understan odern technologies and		mponents of comp	uter networks, variou	is protocols,				
4		gain conceptual unde		re Defined Networ	ks (SDN)					
			Outcomes (CO) w							
At the		of the course, the stud		,						
CO1		esign a small TCP/IP N				Apply				
CO2		entify security issues a		solution		Analyze				
CO3		plain concept of cloud		1 1	~~~	Understand				
CO4	Ex	plain OpenFlow chall	enges in SDN, and	developments in SI	DN	Understand				
Modu	ıle		Module	Contents		Hours				
		Introduction to Ne								
		Introduction to Netw			Switching techniques	s.				
Ι		OSI Model, TCP/IP	Model			7				
1		Data Link layer des				l,				
		Elementary Data lin		iding window prot	ocol, Medium acces	s				
		sub layer- Multiple a	A							
		Internet Protocol		1 E						
II		IP Datagram For		-						
11		Prefixes- and Sul Switching and Rou				-				
		Resolution Protocol		livery and Loo	poacks - Addres					
		Transport layer pro								
III		UDP and TCP seg		, TCP state flow	diagram, TCP flov	w 7				
		control, congestion c								
		Application layer p	rotocols:							
IV		Audio video stream		TP,RTCP, SCTP)	, Application laye	er 6				
	protocols, HTTP, SMTP, SNMP, FTP.									
		Security:								
V		The Need of Secur								
·		Attacks. Network Se		uction to Firewalls	, IP Security, Virtua	al				
		Private Networks (V	PN)							

	Cloud Computing and Software Defined Networking(SDN):	
	Business Drivers - Technology Innovations - Basic Concepts and	
VI	Terminology Cloud Characteristics - Cloud Delivery Models - Cloud	6
V I	Deployment Models, Basics and Open flow, SDN Controller, SDN challenges,	0
	SDN and virtualization.	
	SDN and vinualization.	
	Tertherba	
1	Textbooks	
$\frac{1}{2}$	B A Forouzan," Computer Networks", McGraw Hill Education 2016	
2	Chuck Black, "Software defined Networking", Elsevier 2014	
3		
4		
	References	
1	Wayne Tomasi, "Introduction to Data Communication and Networking", 1/e, Pears Education .	on
2	Greg Tomsho, Ed Tittel, David Johnson. "Guide to Networking Essentials", fifth ed	lition,
Ζ	Thomson India Learning, 2007.	
3		
4		
	Useful Links	
1	https://www.cloudflare.com/en-in/learning/ddos/glossary/tcp-ip/	
2	https://networkengineering.stackexchange.com/questions/63278/what-layers-of-the	-tcp-ip-
۷	model- does-an-sdn-involve	
3		
4		

	CO-PO Mapping													
		Programme Outcomes (PO)										PSO		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1			2										2	
CO2		2												1
CO3		1												1
CO4	1	1												1
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	Each CO of the course must map to at least one PO.													

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Assessment

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		W		ge of Engineerin							
			· · · · · · · · · · · · · · · · · · ·	Y 2023-24							
			Cour	se Information							
Progra	mme		B.Tech. (Electroni	ics Engineering)							
Class,	Semes	ster	Third Year B. Tec	h., Sem. VI							
Course	e Code	9	6EN335								
Course	e Nam	e	Professional Elect	ive-IV: CMOS Digit	al VLSI Design						
Desire	d Req	uisites:	Digital Electronics Microelectronics	s, Electronic Circuits	Analysis and Design,						
Te	achin	g Scheme		Examination Sc	cheme (Marks)						
Lectur	·e	2 Hrs/week	MSE	ISE	ESE	Total					
Tutori	al	1 Hr/week	30	20	50	100					
Practio	cal	-		· · · · · ·							
Intera	ction	Credits: 3									
			Cou	rse Objectives							
1					vith emphasis on unifi	ed model.					
2	2 <i>Explain</i> the steps involved in manufacturing process of MOS devices.										
3					sions of MOS transist CMOS based systems						
4					al and sequential logic						
) with Bloom's Tax							
At the		/	students will be abl								
CO1	-	ain the basic	*	ical principles invol	ved in the process	of Understand					
CO2	Mod	el sub-micron, o	leep submicron MC	S transistors and Int	erconnects.	Apply					
CO3					evices to design CMC	OS Analyze					
			area, speed and pow		ainensite and Campant	al Create					
CO4	Logi	c Circuits by c			circuits and Sequent is like area, speed an						
I	powe	er.									
Modu	le		Mod	ule Contents		Hours					
	N	IOS Transistor	Theory								
I					Behaviour, Seconda	ry 3					
				insistor, Technology	Scaling.						
II			Process for CMOS		ted Circuits, Therm	al 2					
		onsiderations in		rackaging integra							
		MOS Inverter	<u> </u>								
III		Static and Dynamic Behaviour of CMOS Inverter, Power and Energy-Delay, 6									
		Impact of Technology Scaling on Inverter Metrics.									
			ational Logic Circ								
IV	IVStatic CMOS Logic Design, Dynamic CMOS Logic Design, Comparison6between the two Design Styles.6										
			ial Logic Circuits								
.				nic Latches and Rea	gisters, Pulse Register	rs,					
V	N	on-Bistable Se	equential Circuits:		rcuit, Ring Oscillato						
	V	oltage Controll	ed Oscillator.								

	Interconnect and Semiconductor Memories
	Electrical Models of Wires, Lumped RC Model, Distributed rc line,
VI	Transmission Line; Memory Classification, Memory Architectures and Building 4
	Blocks, Memory Core: ROM, RAM.
	Text Books
	Jan M. Rabaey, Anantha Chandrakasan, Borivoje Nikolic, "Digital Integrated Circuits-A Design
1	Perspective", 2 nd Edition, Prentice-Hall India Learning Pvt. Limited/ Pearson Education, 2014.
•	Sung-Mo Kang, Yusuf Leblebici, "CMOS Digital Integrated Circuits: Analysis and Design", 3rd
2	Edition, McGraw-Hill Education (India) Pvt. Ltd., 2015.
3	
4	
	References
1	Neil Weste, Kamran Eshraghian, "Principles of CMOS VLSI Design: Analysis and Design",
1	Addison Wesley/Pearson Education, 2008
2	William Dally and John Poulton, "Digital System Engineering", Cambridge University Press,
2	Reprint 2007.
3	
4	
	Useful Links
1	https://nptel.ac.in/courses/108/107/108107129/
2	https://ocw.mit.edu/courses/electrical-engineering-and-computer-science/6-374-analysis-and-
	design-of-digital-integrated-circuits-fall-2003/index.htm
3	
4	

	CO-PO Mapping													
		Programme Outcomes (PO) PSO												
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	2													1
CO2			2											1
CO3		3	2											2
CO4		2	3											2
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	Each CO of the course must map to at least one PO.													

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		Walc		of Engineering		
			AY	2023-24		
			Course I	Information		
Progra	mme		B.Tech. (Electron	nics Engineering)		
Class, S	Semester		Third Year B. Te	ch., Sem VI		
Course	Code		6EN336			
Course	Name		Professional Elec	tive IV: Digital Ima	ge Processing	
Desired	l Requisit	tes:	Digital Signal Pro	ocessing		
ſ	Feaching	Scheme		Examination So	cheme (Marks)	
Lectur	e	2 Hrs/week	MSE	ISE	ESE	Total
Tutoria	al	1 Hr/ week	30	20	50	100
				Credi	its: 3	
			Course	Objectives		
1			of the field of imag			
2			¥	l their implementati	on.	
3	To apply		ng algorithms for re		- ·	
A 4 41a a 4				ith Bloom's Taxon	omy Level	
CO1			ents will be able to		images and colour	Apply
COI	images	gitai iiiage ciii	lancement teening	ues for gray searc	images and colour	Арргу
CO2	<u> </u>	various image so	egmentation techni	ques		Analyze
CO3				nage compression to	echniques	Evaluate
CO4	Identify i	mage representa	ation and description	n techniques		Understand
Modul			Module			Hours
			ital Image Proces			
Ι					ponents of Image	5
				els. Image file forma	nage sampling and	5
		ge Enhanceme	<u> </u>	is. mage me form		
				ation - Histogram	processing, Spatial	
II	filter	ring - smoothing	g filters, sharpenir	ng filters ; Frequence	cy Domain: Fourier	5
				main filters, shar	pening filters,	
		ographic filterin		·····	T	
				nage Compression	f image blur- Noise	
					ind de convolution,	7
III					einer, least square,	/
				n of compression		
				Shannon Fano codin	ng, Huffman coding,	
		form based com	<u>.</u>			
		or Image Proce	0	eudo color image 1	rocessing basics	
IV				ansforms, smoothing		7
		r segmentation.		instorms, smoothing	5 and sharpening,	
		ge Segmentatio	n			
	Clas	sification of Im	age segmentation	Techniques, Region		
V				ntation, Classificati		7
				orm, Clustering Te	chniques,	
	Wate	ershedTransform	nation.			

	Representation & Description
VI	Chain codes - Polygonal Approximations – signatures - Boundary segments - 7
	Skeletons; Boundary Descriptors - Regional descriptors.
	Textbooks
1	R.C. Gonzalez and R.E. Woods, "Digital Image Processing", 3 rd Edition, Prentice-Hall,
2	Pratt, W.K., "Digital Image Processing", John Wiley and Sons, New York, 1978.
3	
4	
	References
1	A.K. Jain, "Fundamentals of Digital Image Processing"
2	M Sonka, V Hlavac and R Boyle, "Image Processing, Analysis and Machine Vision", PWS
2	1999
3	
4	
	Useful Links
1	www.nptel.com
2	
3	
4	

	CO-PO Mapping													
		Programme Outcomes (PO)									PS	50		
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3												2	3
CO2		3											2	
CO3	3												2	3
The stress	The strength of manning is to be written as 1. Law 2. Medium 2. High													

The strength of mapping is to be written as 1: Low, 2: Medium, 3: High Each CO of the course must map to at least one PO.

Assessment

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MSE shall be typically on modules 1 to 3.

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		Walc		of Engineerin d Autonomous Institu			
				2023-24			
				Information			
Progra	amme		B.Tech. (Electro	nics Engineering)			
	Semester		Third Year B. Te				
	e Code		6OE364				
Cours	e Name		Cyber Physical S	System			
Desire	d Requisi	tes:		-			
			1				
I	Teaching	Scheme		Examination	Scheme (Marks)		
Lectur	re	3 Hrs/week	MSE	ISE	ESE	r	Fotal
Tutori	ial	-	30	20	50		100
				Cre	dits: 3	1	
			1				
			Course	Objectives			
1	To illustr	ate the fundame		byber Physical Syst	tems		
2	1		per Physical Syster				
3	To enable	e the students fo	or the design and de	evelopment of CPS	5		
4							
41	1 0 1		× /	vith Bloom's Taxo	onomy Level		
			lents will be able to	,		TT	1
CO1 CO2		the components	d components of C	LPS			derstand
$\frac{CO2}{CO3}$			for given Applica	tions			nalyze Create
$\frac{CO3}{CO4}$	Design u	le et b bystellis	i for given Applied	10115			Teate
	1						
Modu			Module	e Contents			Hours
Ι	Introc Appli		er Physical System,	s, various compone , Design aspects of	ents of CPS, f Cyber Physical sys	stem,	7
Π		0	•				
					election criteria of ors. Wireless sense		8
III	Senso Senso wirelo of WS	rs, Sensor Instr or Network an or Network, Wi ess sensor netw SN Short distar	rumentation, Conc d Protocol ireless Sensor Net york, Gateway fun nee protocols : Blu	cept of Smart sens work, working of ctions, Data Aggr uetooth, BLE (Blu	WSN, routing in regations, design is uetooth Smart),	ors	8
III IV	Senso Senso wireld of WS Zigbe Embo Introd	rs, Sensor Instr or Network an or Network, Wi ess sensor netw SN Short distar ee, and Industri edded system c luction to Embe	rumentation, Conc d Protocol ireless Sensor Net york, Gateway fun nee protocols : Blu al protocol Modbu omputing	cept of Smart sens work, working of ctions, Data Aggr uetooth, BLE (Blu us, Mbus, 6LoWP	WSN, routing in regations, design is uetooth Smart),	sues	
	Senso Senso wireld of WS Zigbe Embo Introd and s CPS s	rs, Sensor Instr or Network an or Network, Wi ess sensor netw SN Short distar edded system c luction to Ember ystem design Security becurity, Holisti	rumentation, Conc d Protocol ireless Sensor Net vork, Gateway fun nee protocols : Blu al protocol Modbu omputing edded system, Arch	cept of Smart sens work, working of actions, Data Aggr aetooth, BLE (Bh us, Mbus, 6LoWP nitecture, Programi	Sors, Wireless sense WSN, routing in regations, design is uetooth Smart), PAN, IEC68XX ming aspects, periph Security Technolog	sues	5
IV	Senso Senso wireld of WS Zigbe Embo Introd and s CPS s Prince	rs, Sensor Instr or Network an or Network, Wi ess sensor netw SN Short distar e, and Industri edded system c luction to Embe ystem design Security security, Holisti pal security req E Study	rumentation, Conc d Protocol ireless Sensor Net vork, Gateway fun nee protocols : Blu al protocol Modbu omputing edded system, Arch c Approach to Sec juirements, Security	cept of Smart sens work, working of actions, Data Aggr actooth, BLE (Blu us, Mbus, 6LoWP nitecture, Programm urity, Overview of	WSN, routing in regations, design is uetooth Smart), PAN, IEC68XX ming aspects, periph Security Technolog attacks to CPS.	sues	5
IV V	Senso Senso wireld of WS Zigbe Embo Introd and s CPS s Prince	rs, Sensor Instr or Network an or Network, Wi ess sensor netw SN Short distar e, and Industri edded system c luction to Embe ystem design Security security, Holisti pal security req E Study	rumentation, Conc d Protocol ireless Sensor Net vork, Gateway fun nce protocols : Blu al protocol Modbu omputing edded system, Arch c Approach to Sec juirements, Security	cept of Smart sens work, working of actions, Data Aggr actooth, BLE (Bh us, Mbus, 6LoWP nitecture, Programm urity, Overview of y Issues, Types of a DA, general case s	WSN, routing in regations, design is uetooth Smart), PAN, IEC68XX ming aspects, periph Security Technolog attacks to CPS.	sues	5 7 5
IV V VI 1	Senso Senso wireld of WS Zigbe Embo Introd and sy CPS s Prince CASI Indus	rs, Sensor Instr or Network an or Network, Wi ess sensor netw SN Short distar edded system c luction to Embe ystem design Security security, Holisti pal security req E Study try Automation	rumentation, Conc d Protocol ireless Sensor Net vork, Gateway fun nee protocols : Blu al protocol Modbu omputing edded system, Arch c Approach to Sec juirements,Security , Smart Grid, SCA Ter id B. Omer Elloum	cept of Smart sens work, working of actions, Data Aggr actooth, BLE (Bh us, Mbus, 6LoWP nitecture, Programm urity, Overview of y Issues, Types of a DA, general case s xtbooks	WSN, routing in regations, design is uetooth Smart), PAN, IEC68XX ming aspects, periph Security Technolog attacks to CPS.	sues nerals gies	5 7 5 8
IV V VI	Senso Senso wireld of WS Zigbe Embo Introd and sy CPS s Prince CASI Indus	rs, Sensor Instr or Network an or Network, Wi ess sensor network SN Short distar e, and Industri edded system c luction to Ember ystem design Security eccurity, Holisti pal security req E Study try Automation	rumentation, Conc d Protocol ireless Sensor Net vork, Gateway fun nee protocols : Blu al protocol Modbu omputing edded system, Arch c Approach to Sec juirements,Security , Smart Grid, SCA Ter id B. Omer Elloum	cept of Smart sens work, working of actions, Data Aggr actooth, BLE (Bh us, Mbus, 6LoWP nitecture, Programm urity, Overview of y Issues, Types of a DA, general case s xtbooks	WSN, routing in regations, design is uetooth Smart), PAN, IEC68XX ming aspects, periph Security Technolog attacks to CPS.	sues nerals gies	5 7 5 8

4	
	References
1	Lars T Berger K Iniewski, "Smart Grid Applications, Communications, and Security", Wiley
1	Publications
2	
3	
4	
	Useful Links
1	http://www.cyphylab.ee.ucla.edu
2	
3	
4	

	CO-PO Mapping													
		Programme Outcomes (PO) PSO												
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	2													
CO2		2												
CO3				3										
CO4														
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	of the c	ourse 1	nust m	ap to at	t least c	one PO.								

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

			(Government Aided A AY 20		,					
				formation						
Progr	amme		B.Tech. (Electronic							
	Semester		Third Year B. Tech	<u> </u>						
	e Code		60E365							
	e Name		Biomedical Engine	ering						
	ed Requisites:		Electronics Measur	<u> </u>	umentation					
	Teaching Sche	me		Examination S	Scheme (Marks)					
Lectu		Irs/week	MSE	ISE	ESE	Total				
Futori						100				
				Cre	dits: 3					
			<u> </u>							
			Course C	bjectives						
1	To explain the	e basics bo	dy cell structure and	•	of transducers					
2	To explain the	e different t	ypes of patient moni	toring system						
3			ncept of different M		its					
4	To demonstrat		medical instruments							
			Outcomes (CO) wit	h Bloom's Taxo	onomy Level					
		l of the course, the students will be able to, nderstand CNS-PNS and Cardio pulmonary system Understand								
$\frac{CO1}{CO2}$										
C O2	instrumentatio		for sensing biomedical signals to biomedical Apply							
CO3	Design ECG,I	EEG and E								
CO4		k diagram of patient monitoring systems, X-ray machine, CT								
	scan and Ultra	isonograph	y machine.							
Modu	lo		Module Co	ntonts		Hours				
viouu		ntals of M	edical Instrumentat			IIIUIIS				
					edical signals, Basic					
Ι		Physiological Systems of the body, Sources of Biomedical signals, Basic Medical Instrumentation system, Micro-Electro-Mechanical System (Mems),								
		Wireless Connectivity in Medical Instruments, General Constraints in design								
		of Medical Instrumentation Systems The Origin of Bio potentials, Bio potential Electrodes & Biosensors								
					Drganization of the ectromogram(EMG).					
П	·		•	•		+				
II		Electroencephalogram(EEG), Electroretinogram(ERG) and their recording system, Biomedical signal Analysis and Processing Techniques.								
II	Patient M									
II	System (System Concepts, Cardiac Monitor, Bedside patient Monitoring Systems,								
		Central Monitors, Measurement of Heart rate, Measurement of								
II III		Monitors,	Measurement of	f Heart rate,	Wiedsurennenn of					
	Temperat	Monitors, ture,								
	Temperat	Monitors, ture, ent of resp	iration Rate, Biomed							
III	Temperat Measurem Modern I	Monitors, ture, ent of resp maging S	iration Rate, Biomec ystems	lical Telemetry S		0				
	Temperat Measurem Modern I X-ray m Nuclear I	Monitors, aure, ent of resp maging S achines A Medical In	iration Rate, Biomed y stems nd Digital Radiograp naging Systems, Mag	lical Telemetry S phy, X-ray Con gnetic Resonanc	Systems nputed Tomography, e Imaging Systems,	8				
III	Temperat Measurem Modern I X-ray m Nuclear I Ultrasonic	Monitors, oure, ent of resp maging S achines A Medical In Imaging S	iration Rate, Biomed stems nd Digital Radiograp naging Systems, Mag Systems and Therma	lical Telemetry S phy, X-ray Con gnetic Resonanc l Imaging System	Systems nputed Tomography, e Imaging Systems,	8				
III IV	Temperat Measurem Modern I X-ray m Nuclear I Ultrasonic Assisting	Monitors, aure, ent of resp maging S achines A Medical In Imaging S and Thera	iration Rate, Biomed ystems and Digital Radiograp maging Systems, Mag Systems and Therma peutic Equipment'	lical Telemetry S phy, X-ray Con gnetic Resonanc l Imaging System s	Systems nputed Tomography, e Imaging Systems, ms.	8				
III	Temperat Measurem Modern I X-ray m Nuclear I Ultrasonic Assisting Cardiac Pa	Monitors, ent of resp maging S achines A Medical In Imaging S and Thera cemakers,	iration Rate, Biomed ystems and Digital Radiograp maging Systems, Mag Systems and Therma peutic Equipment'	lical Telemetry S phy, X-ray Con gnetic Resonanc l Imaging System s	Systems nputed Tomography, e Imaging Systems,	8				
III IV	Temperat Measurem Modern I X-ray m Nuclear I Ultrasonic Assisting Cardiac Pa Ventilators	Monitors, ent of resp maging S achines A Medical In Imaging S and Thera cemakers,	iration Rate, Biomed ystems and Digital Radiograp maging Systems, Mag Systems and Therma peutic Equipment'	lical Telemetry S phy, X-ray Con gnetic Resonanc l Imaging System s	Systems nputed Tomography, e Imaging Systems, ms.	8				

Course Contents for BTech Programme, Department of Electronics Engineering, AY2023-24

1	John. G. Webster, "Medical Instrumentation", John Wiley, 2009								
2	Goddes& Baker, "Principles of Applied Biomedical Instrumentation", John Wiley, 2008								
3	Carr & Brown, "Biomedical Instrumentation & Measurement", Pearson, 2004								
4									
References									
1	R.S. Khandpur, "Hand book of Medical instruments", TMH, New Delhi, 1987.								
2	Sanjay Guha,"Medical Electronics and Instrumentation", University Publication, 200.								
3	Edwand J. Bukstein, "Introduction to Biomedical electronics", Sane and Co. Inc, 1973								
4									
	Useful Links								
1									
2									
3									
4									

	CO-PO Mapping													
		Programme Outcomes (PO)										PS	50	
	1	2	3	4	5	6	7	8	9	10	11	12	1	2
CO1	3												2	
CO2					3	2							2	
CO3			3										2	
CO4									3				2	
The streng	The strength of mapping is to be written as 1: Low, 2: Medium, 3: High													
Each CO	of the c	course r	nust m	ap to at	least o	one PO.								

The assessment is based on MSE, ISE and ESE.

MSE shall be typically on modules 1 to 3.

ISE shall be taken throughout the semester in the form of teacher's assessment. Mode of assessment can be field visit, assignments etc. and is expected to map at least one higher order PO.

ESE shall be on all modules with around 40% weightage on modules 1 to 3 and 60% weightage on modules 4 to 6.

Walchand College of Engineering, Sangli (Government Aided Autonomous Institute)						
AY 2023-24						
Course Information						
Programme	B.Tech. (Electronics Engineering)					
Class, Semester	Third Year B. Tech., Sem-VI					
Course Code	6HS306					
Course Name	Introduction to Entrepreneurship					
Desired Requisites:						

Teaching	g Scheme	Examination Scheme (Marks)							
Lecture	2 Hrs/week	LA1	LA1	ESE	Tota l				
Tutorial	-	30	30	40	100				
Practical	-								
Interaction	1 Hr/week	Credits: 2							

Course Objectives							
1	- companies of all sizes and industries.						
2 To examine the entrepreneurial process from the generation of creative ideas to exploring feasibility to creation of an enterprise for implementation of the ideas.							
3	3 To create and present a business plan for a technology idea.						
4 To provide the background, tools, and life skills to participate in the entrepreneurial process within a large company, in a new venture, or as an investor.							
Course Outcomes (CO) with Bloom's Taxonomy Level							
CO1	Exploit the concept, meaning and features of entrepreneurship.	Apply					
CO2	Analyse the business environment in order to identify business opportunities	Analyse					
CO3	Evaluate the legal and financial conditions for starting a business venture.	Evaluate					
CO4	Interpret the business plan, pitch to the investor and build the enterprise.	Create					

Module	Module	Hours
	Contents	
	The entrepreneurial perspective	
Ι	The Entrepreneurial Mind-Set, Corporate Entrepreneurship,	5
	Generating and Exploiting New Entries	
	From idea to the opportunity	
II	Creativity and the Business Idea, Identifying and Analyzing	6
	Domestic and International Opportunities, Protecting the Idea and	
	Other Legal Issues for the Entrepreneur	
	From the opportunity to the business plan	
III	The Business Plan: Creating and Starting the Venture, The	8
	Marketing Plan	
	, The Organizational Plan , The Financial Plan	
	From the business plan to funding the venture	4
IV	Sources of Capital, Informal Risk Capital, Venture Capital, and	4
	Going Public	

V	From funding the venture to launching, growing, and ending the new venture	7					
V	Strategies for Growth and Managing the Implications of Growth , 7 Accessing Resources for Growth from External Sources , Succession						
	Planning and Strategies for Harvesting and Ending the Venture						
	Case Study						
VI	Case study of 3 to 4 successful entrepreneurs covering above theory. 6						
V I	Case study of 2 to 3 failure entrepreneurs.						
	Case study of 2 to 5 fandre entrepreneurs.						
	Text Books						
1	Robert D. Hisrich, Michael P. Peters, Dean A. Shepherd , "ENTREPRENEURSHIP" MGH 10 th Edition.						
2	2 Howard , Allan , Donald "Entrepreneurship : Theory / Process / Practice" Cengage Learning 4 th Edition						
3	William Bygrave, Andrew Zacharakis "Entrepreneurship" Wiley 2nd Edition						
	References						
1	Lee A. Swanson "Entrepreneurship and Innovation Toolkit" 3rd Edition						
2	Lee A. Swanson "BUSINESS PLAN DEVELOPMENT GUIDE" 8th Edition						
3	Hitesh Jhanji "ENTREPRENEURSHIP AND SMALL BUSINESS MA	ANAGEMENT"					
	Lovely Professional University, India						
	Useful Links						
1							
2							
3							
4							
5							

	CO-PO Mapping														
		Programme Outcomes (PO)										PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3
CO1															
CO2															
CO3															
CO4															
The streng	gth of 1	nappir	ig is to	be wri	itten as	1,2,3;	Where	e, 1:Lo	w, 2:N	ledium	, 3:Hig	gh			

Each CO of the course must map to at least one PO.

Assessment

The assessment is based on in-semester examinations in the form of online quiz and group activity of 30 marks each as LA1 and LA2. There shall be 1 End-Sem examination (ESE) of 40 marks. LA1 shall be typically on modules 1,2 and 3, and LA2 shall be typically on modules 4,5 and 6. ESE shall be on all modules.

	Assessment Plan based on Bloom's Taxonomy Level (Marks)									
E	Bloom's Taxonomy Level	T1	T2	ESE	Total					
1	Remember									

2	Understand				
3	Apply	5	5	12	22
4	Analyze	5	5	12	22
5	Evaluate	4	4	11	19
6	Create	6	6	25	37
	Total	30	30	40	100

		Walc		f Engineering, Autonomous Institute							
			1	23-2024	,						
			Course I	nformation							
Progra	mme		B.Tech. (Electron	ics Engineering)							
Class, S	Semester	•	Third Year B. Tech., SemVI								
Course	Code		6HS303								
Course	Name		Humanities II- German Language								
Desired	l Requisi	ites:	10+2 level Englis	h							
r	Feaching	g Scheme									
Lectur	e		LA1	ESE	Total						
Tutorial			30	30	40	100					
Practic	al	-			I						
Interac	tion	2 Hrs/week		Credi	ts: 2						
			1								
			Course	Objectives							
1	To acqu	uire German lang									
2		o acquire German language skills both written and spoken nable students to communicate in German language in day to day situations									
			`````````````````````````````````	th Bloom's Taxon	omy Level						
CO1			German in differen		-	Apply					
CO2	Handle	oral and written	communications in	German language	confidently	Understand					
	_										
Modu		dule 1 : Greeti		Contents		Hours					
Ι	2. C 3. E 4. F	<ol> <li>To introduce oneself and others</li> <li>Greeting people/colleagues at office/work-place etc.</li> <li>Exchanging information about country of origin</li> <li>Place of residence, professions</li> <li>Things that we eat and drink</li> </ol>									
Module 2 : Days, I1. Date and Days of2. Names of monthII3. Numbers 1 to 104. Names of Contin5. Languages and N6. Health and Parts			f Week s 00 uents, Countries an Nationalities, mair of body	5							
III 1. Alph 2.Perso 3.Germ 4.Gend		Alphabet, Personal Pronou German Articles Genders Plural Forms	ticles								
IV	1.Fo 2.Pr 3. C 4.Vo 5.D	odule 4 :Gran orming question repositions, Conjunctions, erbs ative and Accus		examples,		6					

	Module 5 : Oral Communication							
V	1. Asking for and telling telephone numbers with dial code numbers							
	<ol> <li>Making request</li> <li>Word order in contenace/statements and full question</li> </ol>	5						
	3. Word order in sentences/statements and full question							
	<ul><li>4. Speak on given topic</li><li>5. Asking questions (Forming Question)</li></ul>							
	Module 6 : Written Communication : Basic Writing Skills							
<b>X</b> / <b>T</b>	1. Paragraph Writing							
VI	2. Comprehension							
	3. Short Essay Writing							
	4. Filling in Personal Information							
	Text Books           .Hartmut Auf der strasse, Heiko Bock, Mechthild Gerdes, Jutta Mueller, Helmut							
	Mueller, "Themen Aktuell1- Deutsch als Fremdsprache-Kursbuch", Max Hueber							
1	Verlag, Munich, Germany and Langers International Pvt.Ltd., New Delhi, ISBN: 3-19-0001690							
	9,Reprint 2014							
	.Hartmut Auf der strasse, Heiko Bock, Mechthild Gerdes, Jutta Mu	eller Heln						
2	Hartmut Auf der strasse, Heiko Bock, Mechthild Gerdes, Jutta Mueller, Helmu Mueller, "Themen Aktuell1- Deutsch als Fremdsprache-Arbeitsbuch", Max Huebe							
2	Verlag, Munich, Germany and Langers International Pvt.Ltd., New Delhi ,ISBN: 3-19-011690							
	3,Reprint 201	Max III						
3	Alan B, Jones A."Themen Aktuell 1- Deutsch als Fremdsprache - Glossar", Max Hueb Verlag, Munich, Germany and Langers International Pvt.Ltd., New Delhi ,ISBN: 3-1							
	0001690-9,Reprint 2014							
	Defenences							
1	References           Archana Gogate, "German Workbook", Shubhasha Publications,Pune, Reprint Juli	lv 2016						
	Stefanie Dengler, Paul Rusch, Helen Schmitz, Tanja Sieber, "Netzwerk A1- Deutsch a							
2	FremdspracheKursbuch ",Klett Langenscheidt, Munich,Germany and GOYAL Publishers Pu							
	Ltd.,New Delhi, First Indian edition-2015Stefanie Dengler,Paul Rusch,Helen Schmitz,Tanja Sieber, "Netzwerk A1- Deutsch							
3	alsFremdspracheArbeitsbuch ",Klett Langenscheidt,Munich,Germany and GOYAL Publishe							
	Pvt.Ltd.,New Delhi, First Indian edition-2015							
4	Stefanie Dengler, Paul Rusch, Helen Schmitz, Tanja Sieber, Gavin Schalliol"Netzwerk A Deutsch als Fremdsprache- Glossar ", Klett Langenscheidt, Munich, Germany and GOYA							
	Publishers Pvt.Ltd.,New Delhi, First Indian edition-2015							
1	Useful Links							
1	www.klett-sprachen.de/netzwerk							
1 2 3								

CO-PO Mapping															
	Programme Outcomes (PO)											PSO			
	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3
CO1										1					
CO2										1					
The strength of mapping is to be written as 1,2,3; Where, 1:Low, 2:Medium, 3:High															
Each CO of the course must map to at least one PO.															

The assessment is based on 2 in-semester evaluations (LA) of 30 marks each, end-sem examination (ESE) of 40 marks.

LA1 and LA2 are based on the modules taught (typically Module 1-3) and ESE is based on all modules with 30-40% weightage on modules before LA1 and 60-70% weightage on modules LA2.